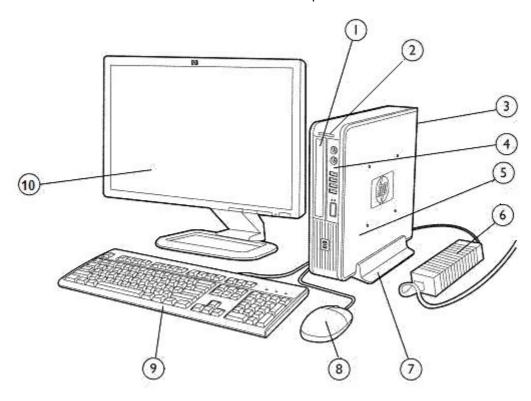
Overview

Ultra-slim Desktop



- 1. Optical Disc Drive (slimline)
- 2. Secure Digital (SD) Card Reader
- 3. Rear I/O includes (6) USB 2.0 ports, DisplayPort and VGA video interfaces, PS/2 mouse and keyboard ports, RJ-45 network interface, audio in/out jacks
- 4. Front I/O includes (4) USB 2.0 ports, dedicated headphone output, and a microphone/headphone jack

- 5. 2.5" internal hard disk drive bay
- 6. 135W 87% efficient external Power Adapter
- 7. HP USDT Tower Stand (sold separately)
- 8. HP Optical Mouse
- 9. HP Keyboard
- 10. HP Monitor (sold separately)

Overview

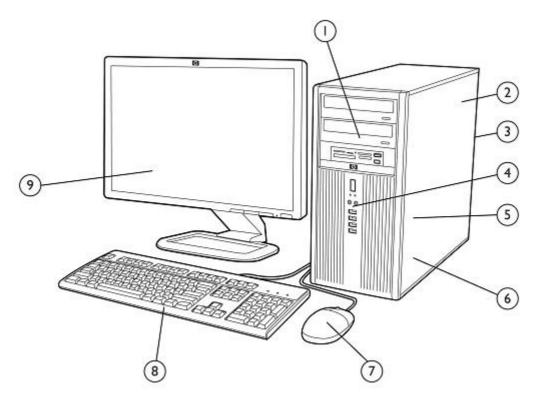
Small Form Factor 9 8 7 6 5

- 1. Rear I/O includes (6) USB 2.0 ports, serial port, PS/2 mouse and keyboard ports, RJ-45 network interface, DisplayPort and VGA video interfaces, and audio in/out jacks
- 2. Low profile expansion slots include (1) PCI slot, (2) PCI Express x1 slots and (1) PCI Express x16 graphics slot
- 3. Front I/O includes (4) USB 2.0 ports, dedicated headphone output, and a microphone/headphone jack
- 4. HP Optical Mouse
- 5. HP Keyboard

- $6.\ 3.5^{\prime\prime}$ external drive bay supporting a media card reader or a secondary hard disk drive
- 7. 5.25" external drive bay supporting an optical disk drive
- 8. 3.5" internal drive bay supporting primary hard disk drive
- 9. 240W standard or 89% high efficiency Power Supply
- 10. HP Monitor (sold separately)

Overview

Convertible Minitower



- 1. (3) 5.25" external drive bays supporting optical disk drives, removable hard disk drives, or the HP Media Card Reader
- 2. 320W standard or 89% high efficiency Power Supply
- 3. Rear I/O includes (6) USB 2.0 ports, serial port, PS/2 mouse and keyboard ports, RJ-45 network interface, DisplayPort and VGA video interfaces, and audio in/out jacks
- 4. Front I/O includes (4) USB 2.0 ports, dedicated headphone output, and an auto detecting microphone/headphone jack

- 5. (3) 3.5" internal drive bays supporting multiple hard disk drives
- 6. Full height expansion slots include (3) full-length PCI slots, (1) PCI Express x1 slot, and (2) full-length PCI Express x16 graphics slots

NOTE: 2nd PCle x16 slot has x4 connectivity.

- 7. HP Optical Mouse
- 8. HP Keyboard
- 9. HP Monitor (sold separately)



Overview

At A Glance

- Designed for long-term deployment within corporate, enterprise, public sector and mid-market commercial organizations
- Choice of three professional chassis form factors to accommodate any desired mix between expandability and size
- BIOS developed and engineered by HP for better security, manageability and software image stability
- Intel® Q45 Express chipset featuring integrated GMA 4500 integrated graphics
- DDR3 Synchronous Dynamic Random Access Memory (SDRAM)
- Intel® Core 2 Processor with vPro Technology (requires select processors)
- Supports industry standard management protocols including Intel Standard Manageability and DASH 1.1 (via optional Broadcom NIC card)
- Integrated dual independent monitor support via both a VGA and DisplayPort video interface
- Standard efficiency or 89% high efficiency energy saving power supplies available on the CMT and SFF models
- 87% efficient energy saving external power adapter standard with USDT models
- ENERGY STAR qualified models available (dependent upon the desired configuration)
- CMT and SFF models can be configured with multiple hard disk drives in a RAID array
- Guaranteed lengthy purchase lifecycles and image stability
- Software image fully compatible across all models and form factors
- Created using industry leading Design for Environment standards
- Selected configurations with global availability easily set up and ordered through HP.com Business to Business portals (http://h10019.www1.hp.com/business-site/index.html)
- Tailored HP Factory Express deployment and lifecycle services available (http://h71028.www7.hp.com/enterprise/cache/97688-0-0-225-121.aspx)
- Protected by HP Services, including standard warranties up to 5-5-5 (terms and conditions vary by country; certain restrictions and exclusions apply)
- Tool-less serviceability features for easier upgrades and repairs



Standard Features and Configurable Components (availability may vary by country)

Operating Systems

Preinstalled

- Genuine Windows Vista Business (32-bit)¹
- Genuine Windows Vista Home Basic1
- Genuine Windows 7 Home Basic Edition (32-bit)²
- Genuine Windows 7 Home Premium Edition (32-bit or 64-bit)²
- Genuine Windows 7 Professional Edition (32-bit or 64-bit)²
- Genuine Windows 7 Professional Edition with a custom downgrade to Genuine Windows XP Professional^{2,3}
- FreeDOS

Supported

- Genuine Windows Vista Enterprise Edition 1
- Genuine Windows 7 Enterprise Edition²
- Genuine Windows 7 Ultimate Edition²
- Novell SUSE Linux Enterprise Desktop 114

Certified

Red Hat Desktop RHEL⁴

- ⁴ The following features are not supported on Linux certified systems:
 - HP 22-in-1 media card reader
 - Trusted Platform Module (TPM) 1.2 Security Chip
 - Intel Pro 1000 CT GbE NIC
 - Broadcom NetXtreme GbE Ethernet Plus NIC
 - HP 802.11b/g/n wireless NIC (SFF and MT)
 - Intel WiFi Link 5100 a/b/g/n wireless NIC (USDT)
 - LSI 56K Int'l SoftModem
 - HP USB Smartcard keyboard
 - HP Serial port adapter
 - HP Parallel port adapter
 - HP eSATA port adapter
 - HP FireWire/IEEE 1394 I/O card



¹ Certain Windows Vista product features require advanced or additional hardware. See www.microsoft.com/windowsvista/getready/hardwarereqs.mspx and www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: www.windowsvista.com/upgradeadvisor

² System may require upgraded and/or separately purchased hardware and/or a DVD drive to install the Windows 7 software and take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

³ Windows 7 Professional disk may be included for future upgrade if desired. To qualify for this downgrade an end user must be a business (including governmental or educational institutions) and is expected to order at least 25 customer systems with the same custom image.

Standard Features and Configurable Components (availability may vary by country)

Value Added Software (included with all models; not included when configured with FreeDOS)

- HP ProtectTools Security Suite
- HP Software Management Agent
- Computrace for Desktops agent (optional)

- HP Insight Diagnostics
- PDF Complete

Value Added Software (included with select models; not included when configured with FreeDOS)

- Computer Setup Utility
- McAfee Total Protection Anti-Virus*
- Roxio Creator Business
- HP Power Manager

- HP Total Care Advisor
- Microsoft Office Trial Version
- Firefox HP Virtual Browser
- Corel WinDVD
- * 60 day trial period for McAfee Total Protection for Small Business software. Internet access required to receive updates. First update included. Subscription required for updates thereafter.

HP Client Management Solutions (available for free download from the Internet)

http://www.hp.com/go/easydeploy)

- HP Client Automation Starter*
- HP SoftPaq Download Manager

- HP Client Catalog for Microsoft SMS
- HP Systems Software Manag
- * Available from your HP Sales Representative or HP Channel Partner

Value Added Services and Features

- HP Stable Platform Program
- Intel Stable Platform Program
- Business-to-Business Portals
- HP Global Series Services

- Factory Express Deployment and Lifecycle Services
- Intel Standard Manageability
- Intel Core 2 Processor with vPro Technology
- Trusted Platform Module (TPM) v1.2*
- * TPM module disabled where restricted by law, i.e. Russia.

Service and Support

On-site warranty and service¹: three year (3/3/3) limited warranty and service offering delivers three years of parts, labor and on-site repair. Response time is next business day² and includes free telephone support³ 24 x 7. Global coverage² ensures any product purchased in one country and transferred to another non-restricted country will remain fully covered under the original warranty and service offering. Some countries/regions do not offer one year onsite and labor.

- ¹ Terms and conditions may vary by country. Certain restrictions and exclusions apply.
- ² On-site services may be provided pursuant to a service contract between HP and an authorized HP third party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.
- ³ Technical telephone support applies only to HP configured, HP and HP qualified third party hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.

Chipset

Intel Q45 Express

X X X



Standard Features and Configurable Components (availability may vary by country)

Processor	USDT	SFF	CMT
Intel Celeron Processors (dual core):			
Intel Celeron E3200 Processor 2.40 GHz, 1M L2 cache, 800 MHz FSB	Χ	Χ	Χ
Intel Celeron E3300 Processor 2.50 GHz, 1M L2 cache, 800 MHz FSB	Χ	Χ	Χ
Intel Pentium Processors:			
Intel Pentium E5300 Processor 2.60 GHz, 2M L2 cache, 800 MHz FSB	Χ	Χ	Χ
Intel Pentium E5400 Processor 2.70 GHz, 2M L2 cache, 800 MHz FSB	Χ	Χ	Χ
Intel Pentium E6300 Processor 2.80 GHz, 2M L2 cache, 1066 MHz FSB	Χ	Χ	Χ
Intel Pentium E6500 Processor 2.93 GHz, 2M L2 cache, 1066 MHz FSB	Χ	Χ	Χ
Intel Core 2 Duo Processors:			
Intel Core 2 Duo E7500 Processor 2.93 GHz, 3M L2 cache, 1066 MHz FSB	Χ	Χ	Χ
Intel Core 2 Duo E7600 Processor 3.06 GHz, 3M L2 cache, 1066 MHz FSB	Χ	Χ	Χ
Intel Core 2 Duo E8400 Processor 3.0 GHz, 6M L2 cache, 1333 MHz FSB with vPro Technology	Χ	Χ	Χ
Intel Core 2 Duo E8500 Processor 3.16 GHz, 6M L2 cache, 1333 MHz FSB with vPro Technology	Χ	Χ	Χ
Intel Core 2 Duo E8600 Processor 3.33 GHz, 6M L2 cache, 1333 MHz FSB with vPro Technology	Χ	Χ	Χ
Intel Core 2 Quad Processors:			
Intel Core 2 Quad Q8400 Processor 2.66 GHz, 4M L2 cache, 1333 MHz FSB		Χ	Χ
Intel Core 2 Quad Q8400s Processor (low power) 2.66 GHz, 4M L2 cache, 1333 MHz FSB	Χ		
Intel Core 2 Quad Q9505 Processor 2.83 GHz, 6M L2 cache, 1333 MHz FSB with vPro Technology		Χ	Χ
Intel Core 2 Quad Q9505s Processor (low power) 2.83 GHz, 6M L2 cache, 1333 MHz FSB with vPro Technology	Χ		
Intel Core 2 Quad Q9550 Processor 2.83 GHz, 12M L2 cache, 1333 MHz FSB with vPro Technology		Χ	Χ
Intel Core 2 Quad Q9550s Processor (low power) 2.83 GHz, 12M L2 cache, 1333 MHz FSB with vPro Technology	Χ		
Intel Core 2 Quad Q9650 Processor 3.0 GHz, 12M L2 cache, 1333 MHz FSB with vPro Technology		Χ	Χ

Intel Core 2 Processor with vPro Technology

All HP Compaq 8000 Elite Series models featuring this technology include processors which are part of the Intel 2010 Stable Image



Standard Features and Configurable Components (availability may vary by country)

Platform Program (SIPP) designed to ensure the stability promise inherent in the value proposition of the HP Compaq 8000 Elite Series Business PC, thus making these models the most stable, secure, and manageable platforms available to enterprises today.

The 2010 SIPP processors are:

- Core 2 Duo E8400, E8500, E8600
- Core 2 Quad Q9505, Q9505s, Q9550, Q9550s, Q9650

Intel's Core 2 Processor with vPro Technology suite of features includes:

Intel Advanced Management Technology (AMT) v5.0 – An advanced set of remote management features and functionality which provides network administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 5.0 includes all features described as part of Intel Standard Manageability plus the following advanced management functions:

- Fast Call for Help a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection
- Remote Scheduled Maintenance pre-schedule when the PC connects to the IT or service provider console for maintenance.
 Remote PCs can get required patches, be inventoried, etc by connecting to their IT console or Service Provider when it's convenient
- Remote Alerts automatically alert IT or service provider if issues arise
- Access Monitor Provides oversight into Intel® AMT actions to support security requirements

Microsoft NAP Support – Allows AMT 5.0 to gain access to a Microsoft NAP enabled 802.1x network OOB to enable OOB SW updates, inventories, remote diagnostics, etc. NAP is a new platform and solution that controls access to network resources based on a client computer's identity and compliance with corporate governance policy. NAP allows network administrators to define granular levels of network access based on who a client is, the groups to which the client belongs, and the degree to which that client is compliant with corporate governance policy. If a client is not compliant, NAP provides a mechanism to automatically bring the client back into compliance and then dynamically increase its level of network access.

When a client attempts to access the network or communicate on the network, it must present its system health state or proof of health compliance. If a client cannot prove it is compliant with system health requirements (for example, that it has the latest operating system and antivirus updates installed), its access to the network or communication on the network can be limited to a restricted network containing server resources so that health compliance issues can be remedied. After the updates are installed, the client requests access to the network or attempts the communication again. If compliant, the client is granted unlimited access to the network or the communication is allowed.

Redundant Array of Independent Drives (RAID)

Flexible implementation:

- DriveLock is supported while in RAID mode. Users can manage the DriveLock password from within F10 Setup. Locked drives will be displayed as such in the RAID option ROM interface.
- Hard drive information can be viewed within F10 Setup while in RAID mode. Previously, the hard drives will not appear in Drive Configuration when switching to RAID mode.
- DPS Self Test can be executed on physical hard drives while in RAID mode.
- The RAID Setup Utility (accessed through CTRL-I) can be protected by the F10 Setup password.

NOTE: RAID 1 is the only RAID configuration offered via factory configurations. The pre-configured systems:

 Are only available on the CMT and SFF form factors. The USDT does not support RAID as it does not allow for more than one hard disk drive.



Standard Features and Configurable Components (availability may vary by country)

- Are complete RAID systems and have both drives installed. If the CMT is configured with three hard disk drives, the third drive is would be unpartitioned and not part of the RAID array
- Have the necessary Option ROM configuration.
- Are pre-loaded and pre-installed with all required Intel software.
- Include a preinstalled operating system that is mirrored mode out of the box.

Please refer to the HP White Paper titled "Advanced Host Controller Interface (AHCI) and Redundant Array of Independent Disks (RAID) on HP Compaq 8000 Elite Series PCs" at: http://www.hp.com for more information and instructions.

DDR3 Synchronous DRAM NON-ECC System Memory

Memory upgrades are accomplished by adding single or multiple DIMMs of the same or varied sizes. This chart does not represent all possible memory configurations. The HP Compaq 8000 Elite Series PC supports non-ECC DDR3 PC3-10600 (1333 MHz) and PC3-8500 (1066 MHz) memory.

CAUTION: You must shut down the computer and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the computer is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.

Ultra-slim Desktop

Maximum Memory*

Supports up to 8 GB of DDR3 SDRAM using SO-DIMM modules. Slot 1 is black and must always be populated. Not all memory configurations possible are represented below.

NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements.

SO-DIMM Size	S	ot
	Channel A (black)	Channel B (white)
1 GB	1 GB	
2 GB	1 GB	1 GB
(dual channel symmetric)		
4 GB	2 GB	2 GB
(dual channel symmetric)		
8 GB	4 GB	4 GB
(dual channel symmetric)		

^{*} The Intel Q45 Express chipset includes a built-in Management Engine (ME), which allocates memory for manageability functions. Management Engine memory is shared with system memory. If the PC contains a single SO-DIMM, 16 MB of memory is preallocated for it at system startup. If the PC contains two SO-DIMMs, 32 MB of memory is pre-allocated. This memory is not made available to the operating system, just as pre-allocated video memory is not available.

Standard Features and Configurable Components (availability may vary by country)

Small Form Factor and Convertible Minitower

Maximum Memory*

Supports up to 16 GB of DDR3 SDRAM using DIMM modules. Slot 1 is black and must always be populated. Not all memory configurations possible are represented below.

NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.

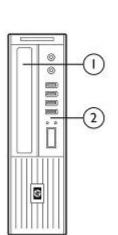
DIMM Size		SI	ot		
	Char	nnel A	Channel B		
	1 (black)	2 (white)	3 (white)	4 (white)	
1 GB	1 GB				
2 GB	1 GB		1 GB		
(dual channel symmetric)					
4 GB	1 GB	1 GB	1 GB	1 GB	
(dual channel symmetric)					
8 GB	2 GB	2 GB	2 GB	2 GB	
(dual channel symmetric)					
16 GB	4 GB	4 GB	4 GB	4 GB	
(dual channel symmetric)					

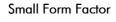
^{*} The Intel Q45 Express chipset includes a built-in Management Engine (ME), which allocates memory for manageability functions. Management Engine memory is shared with system memory. If the PC contains a single DIMM, 16 MB of memory is pre-allocated for it at system startup. If the PC contains two DIMMs, 32 MB of memory is pre-allocated. This memory is not made available to the operating system, just as pre-allocated video memory is not available.

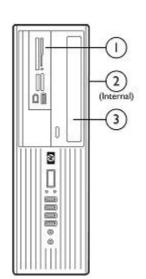
Memory Configurations	USDT	SFF	CMT
1-GB DDR3 SDRAM PC3-10600 (1,333MHz) Non ECC (1 x 1GB)	Χ	Χ	Χ
2-GB DDR3 SDRAM PC3-10600 (1,333MHz) Non ECC (1 x 2GB)	Χ	Χ	Χ
2-GB DDR3 SDRAM PC3-10600 (1,333MHz) Non ECC (2 x 1GB)	Χ	Χ	Χ
3-GB DDR3 SDRAM PC3-10600 (1,333MHz) Non ECC (1GB + 2GB)	Χ	Χ	Χ
4-GB DDR3 SDRAM PC3-10600 (1,333MHz) Non ECC (4 x 1GB)		Χ	Χ
4-GB DDR3 SDRAM PC3-10600 (1,333MHz) Non ECC (1 x 4GB)	Χ	Χ	Χ
4-GB DDR3 SDRAM PC3-10600 (1,333MHz) Non ECC (2 x 2GB)	Χ	Χ	Χ
8-GB DDR3 SDRAM PC3-10600 (1,333MHz) Non ECC (2 x 4GB)	Χ	Χ	Χ
8-GB DDR3 SDRAM PC3-10600 (1,333MHz) Non ECC (4 x 2GB)		Χ	Χ
16-GB DDR3 SDRAM PC3-10600 (1,333MHz) Non ECC (4 x 4GB)		Χ	Χ

Standard Features and Configurable Components (availability may vary by country)

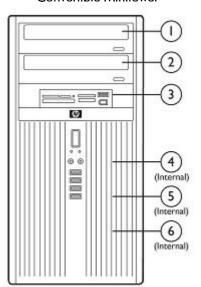
Ultra-slim Desktop











Storage - Drive Supp	ort								
	USDT			SFF			CMT		
	SDR	ODD	HDD SSD	MCR	ODD	HDD SSD	MCR	ODD	HDD SSD
Quantity Supported	1	1	1	1	1	2	1	2	3
Position	1	2	3	1	3	2,1	3	1,2	4,5,6

II	USDT	SFF	CMT
Hard Disk Drives		JI I	CIVII
160GB 2.5" Hard Disk Drive	Χ		
7,200 rpm, 8MB cache, 3.0 GB/s, NCQ, Smart IV			
160GB 3.5" Hard Disk Drive		Χ	Χ
7,200 rpm, 8MB cache, 3.0 GB/s, NCQ, Smart IV			
160GB 2.5" Hard Disk Drive		Χ	Χ
10,000 rpm, 16MB cache, 3.0 GB/s, NCQ, Smart III			
160GB Removable Hard Disk Drive		Χ	Χ
7,200 rpm, 8MB cache, 3.0 GB/s, NCQ, Smart IV			
250GB 2.5" Hard Disk Drive	Χ		
7,200 rpm, 8MB cache, 3.0 GB/s, NCQ, Smart IV	Λ		
250GB 3.5" Hard Disk Drive		Χ	Χ
7,200 rpm, 8MB cache, 3.0 GB/s, NCQ, Smart IV		, ,	,,
250GB Removable Hard Disk Drive		Χ	Χ
7,200 rpm, 8MB cache, 3.0 GB/s, NCQ, Smart IV			
			V
320GB 3.5″ Hard Disk Drive		Χ	Χ
7,200 rpm, 8MB cache, 3.0 GB/s, NCQ, Smart IV			

Standard Features and Configurable Components (availability may vary by country)			
320GB Removable Hard Disk Drive		Χ	Χ
7,200 rpm, 8MB cache, 3.0 GB/s, NCQ, Smart IV			
500GB 3.5" Hard Disk Drive		Χ	Χ
7,200 rpm, 16MB cache, 3.0 GB/s, NCQ, Smart IV			
500GB Removable Hard Disk Drive 7,200 rpm, 16MB cache, 3.0 GB/s, NCQ, Smart IV		Χ	Χ
1 TB 3.5" Hard Disk Drive 7,200 rpm, 16MB cache, 3.0 GB/s, NCQ, Smart IV		Х	Х
Solid State Drives	USDT	SFF	СМТ
64GB 2.5" Solid State Drive	Χ		
5.25-inch Optical Drives	USDT	SFF	СМТ
DVD-ROM Drive ¹		Χ	Χ
SuperMulti LightScribe DVD Writer Drive 1,2,3		Χ	Χ
Blu-Ray Writer Drive		Χ	Χ
Slimline Optical Drives	USDT	SFF	СМТ
DVD-ROM Drive ¹	Χ		
SuperMulti LightScribe DVD Writer Drive ^{1,2,3}	Χ		
¹ For playing DVDs, Corel WinDVD 8			
² For writing CDs, choice of Sonic/Roxio Easy Media Creator 9 orRoxio Business Creator 10 ³ For writing CDs and DVDs, video editing and authoring DVDs, choice of Sonic/Roxio Easy Media Creator 10	or 9 or R	oxio B	usiness
Media Card Readers	USDT	SFF	СМТ
Media Card Reader (22-in-1)		Χ	Χ
Media Card Reader (22-in-1) with 1394 port		Χ	Χ
Secure Digital (SD) HC Reader	Χ		



Standard Features and Configurable Components (availability may vary by country)

Trusted Platform Module (TPM) 1.2 ¹ Stringent Security (via BIOS) ² SATA Port Disablement (via BIOS) Drive Lock RAID Configurations HP ProtectTools Embedded Security Software Serial, Parallel, USB enable/disable (via BIOS) Optional USB Port Disable at factory (user configurable via BIOS) Removable Media Write/Boot Control Power-On Password (via BIOS) Setup Password (via BIOS) Solenoid Hood Lock / Sensor	X X X X X X X X X X X	X X X X X X X X X X X X X X X X X X X	XXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX
Stringent Security (via BIOS) ² SATA Port Disablement (via BIOS) Drive Lock RAID Configurations HP ProtectTools Embedded Security Software Serial, Parallel, USB enable/disable (via BIOS) Optional USB Port Disable at factory (user configurable via BIOS) Removable Media Write/Boot Control Power-On Password (via BIOS) Setup Password (via BIOS) Solenoid Hood Lock / Sensor	X X X X X X X X	X X X X X X X X	X X X X X X X X X
SATA Port Disablement (via BIOS) Drive Lock RAID Configurations HP ProtectTools Embedded Security Software Serial, Parallel, USB enable/disable (via BIOS) Optional USB Port Disable at factory (user configurable via BIOS) Removable Media Write/Boot Control Power-On Password (via BIOS) Setup Password (via BIOS) Solenoid Hood Lock / Sensor	X X X X X X X X	X X X X X X X X	X X X X X X X X
Drive Lock RAID Configurations HP ProtectTools Embedded Security Software Serial, Parallel, USB enable/disable (via BIOS) Optional USB Port Disable at factory (user configurable via BIOS) Removable Media Write/Boot Control Power-On Password (via BIOS) Setup Password (via BIOS) Solenoid Hood Lock / Sensor	X X X X X X X	X X X X X X X	X X X X X X X
RAID Configurations HP ProtectTools Embedded Security Software Serial, Parallel, USB enable/disable (via BIOS) Optional USB Port Disable at factory (user configurable via BIOS) Removable Media Write/Boot Control Power-On Password (via BIOS) Setup Password (via BIOS) Solenoid Hood Lock / Sensor	X X X X X X	X X X X X X	X X X X X X
HP ProtectTools Embedded Security Software Serial, Parallel, USB enable/disable (via BIOS) Optional USB Port Disable at factory (user configurable via BIOS) Removable Media Write/Boot Control Power-On Password (via BIOS) Setup Password (via BIOS) Solenoid Hood Lock / Sensor	X X X X X	X X X X X X	X X X X X X
Serial, Parallel, USB enable/disable (via BIOS) Optional USB Port Disable at factory (user configurable via BIOS) Removable Media Write/Boot Control Power-On Password (via BIOS) Setup Password (via BIOS) Solenoid Hood Lock / Sensor	X X X X X	X X X X X	X X X X X
Optional USB Port Disable at factory (user configurable via BIOS) Removable Media Write/Boot Control Power-On Password (via BIOS) Setup Password (via BIOS) Solenoid Hood Lock / Sensor	X X X X X	X X X X	X X X X
Removable Media Write/Boot Control Power-On Password (via BIOS) Setup Password (via BIOS) Solenoid Hood Lock / Sensor	X X X X	X X X	X X X
Power-On Password (via BIOS) Setup Password (via BIOS) Solenoid Hood Lock / Sensor	X X X X	X X X	X X X
Setup Password (via BIOS) Solenoid Hood Lock / Sensor	X X X	X X	X X
Solenoid Hood Lock / Sensor	X X	Χ	Χ
	Χ		
		Χ	
Support for chassis padlocks and cable lock devices			Χ
¹ TPM module disabled where use is restricted by law; for example, Russia. ² This setting is defaulted to disable, but when enabled, the PW jumper will not clear the BIOS pre-boot auth passwords.	entica	tion	
Network Interface Connection	JSDT	SFF	СМТ
Intel 82567LM GbE Network Connection (integrated)	Χ	Χ	Χ
Intel Gigabit CT Desktop NIC Card		Χ	Χ
Broadcom NetXtreme GbE Ethernet Plus NIC (PCle x1)		Χ	Χ
NOTE: The integrated network connection is required to support the vPro Technology features.			
HP 802.11 b/g/n Wireless NIC (PCle x1)		Х	X
Intel Wi-Fi Link 5100 a/b/g/n Wireless NIC (mini PCI)	Χ		
NOTE: These wireless network interface solutions will disable the vPro Technology features.			
Modem	JSDT	SFF	CMT
LSI Hi-Speed 56K International Soft Modem (PCle x1)		Χ	Χ
Graphics	JSDT	SFF	СМТ
Intel Graphics Media Accelerator 4500 (integrated)	Χ	Χ	Χ
Nvidia GeForce 310 DP PCle x16 Graphics Card	•	X	X
Nvidia Quadro NVS 290 Graphics Card		X	Χ
Nvidia Quadro NVS 295 Graphics Card		X	X
ATI Radeon HD 4550 Graphics Card*		X	X
ATI Radeon HD 4650 DP Graphics Card		X	Χ
HP ADD2 SDVO + DVI-D Video Adapter		X	X
		-	



Standard Features and Configurable Components (availability may vary by country)

* Not available until January 2010.

HP DisplayPort to DVI-D Adapter	Χ	Χ	Χ
HP DisplayPort to VGA Adapter	Χ	Χ	Χ

Audio/Visual	USDT	SFF	CMT
High Definition Audio with Realtek ALC261 codec (all ports are stereo)	Χ	Χ	Χ
Microphone/Headphone* and dedicated headphone front ports	Χ	Χ	Χ
Line-out and Line-In rear Ports*	Χ	Χ	Χ
Multi-streaming capable*	Χ	Χ	Χ
Internal Speaker (standard)	Χ	Χ	Χ
HP Thin USB Powered Speakers	Χ	Χ	Χ
HP TV Tuner Mini PCle Card	Χ		
HP TV Tuner PCle x1 Card		Χ	Χ

^{*} The front microphone port is re-taskable as a Line-in, Microphone-in or Headphone . Rear audio input ports are re-taskable as Line-in or Microphone-in. External speakers must be powered externally. Multistreaming can be enabled in the Realtek control panel to allow independent audio streams to be sent to/from the front and rear jacks. This allows for different audio applications to use separate audio ports on the system. For example, the front jacks could be used with a headset for a communications application while the rear jacks are being used with external speakers and a multimedia application.

Input Devices	USDT	SFF	CMT
PS/2 Standard Keyboard	Χ	Χ	Χ
USB Standard Keyboard	Χ	Χ	Χ
USB SmartCard Keyboard	Χ	Χ	Χ
USB Mini Keyboard	Χ	Χ	Χ
USB & PS/2 Washable Keyboard	Χ	Χ	X
PS/2 Optical Scroll Mouse	Χ	Χ	Χ
USB Optical Scroll Mouse	Χ	Χ	Χ
USB Laser Scroll Mouse	Χ	Х	X

Miscellaneous	USDT	SFF	CMT
FireWire (IEEE 1394) Card		Χ	Χ
Serial Port Adapter		Χ	Χ
Parallel Port Adapter		Χ	Χ
eSATA Port Adapter		Χ	Χ
PC Tower Stand	Χ	Χ	
Configure CMT in desktop orientation			Χ
Rear Port/Cable Control Cover	Χ		



After-Market Options (availability may vary by region)

Communications	USDT	SFF	CMT	Part Number
HP Wireless 802.11 b/g/n NIC Card		Χ	Χ	FH971AA
Broadcom NetXtreme GbE Ethernet Plus NIC Card		Χ	Χ	FS215AA
Intel Gigabit CT Desktop NIC Card		Χ	Χ	FH969AA
LSI Hi-Speed 56K Int'l Soft Modem Card		Χ	Χ	FH970AA
RJ11 Modem Adapter Kit		Χ	Χ	DC131C
NOTE: The use of a NIC Card (wired or wireless) will disable the vPro Technology fea	tures.			
Graphics	USDT	SFF	СМТ	Part Number
ATI Radeon HD 4550 Graphics Card*		Χ	Χ	AT042AA
ATI Radeon HD 4650 DP Graphics Card			Χ	AR566AA
Nvidia Quadro NVS 290 Graphics Card		Χ	Χ	KG748AA
Nvidia Quadro NVS 295 Graphics Card		Χ	Χ	FY943AA
Nvidia GeForce 310 DP PCle x16 Graphics Card		Χ	Χ	VG885AA
HP ADD2 SDVO + DVI-D Video Adapter		Χ	Χ	DY674A
* Not available until January 2010.				
DMS59 DVI Dual-head Connector Cable		Х	Χ	DL139A
HP DVI to DVI cable		Χ	Χ	DC198A
HP DisplayPort To DVI-D adapter	Χ	Χ	Χ	FH973AA
HP DisplayPort To DL DVI-D adapter	Χ	Χ	Χ	NR078AA
HP DisplayPort to VGA Adapter	Χ	Χ	Χ	AS615AA
HP DisplayPort Cable Kit	Χ	Χ	Χ	VN567AA
Hard Disk Drives	USDT	SFF	СМТ	Part Number
HP 160GB SATA NCQ SMART IV Hard Disk Drive		Χ	Χ	PY277AT
HP 250GB SATA NCQ SMART IV Hard Disk Drive		Χ	Χ	PY278AA
HP 500GB SATA NCQ SMART IV Hard Disk Drive		Χ	Χ	KW347AA
HP eSATA Adapter		Χ	Χ	FH966AA
HP Removable SATA Hard Drive Enclosure (frame & carrier)		Χ	Χ	RY102AA
HP Removable SATA Hard Drive Enclosure (Carrier Only)		Χ	Χ	RY103AA



Input/Output Devices	USDT	SFF	CMT	Part Number
HP PS/2 Standard Keyboard	Χ	Χ	Χ	DT527A
HP USB Standard Keyboard	Χ	Χ	Χ	DT528A
HP USB Gray Keyboard	Χ	Χ	Χ	DT529A
HP 2.4GHz Wireless Keyboard & Mouse	Χ	Χ	Χ	NB896AA
HP USB Mini Keyboard	Χ	Χ	Χ	AS601AA
HP USB Washable Keyboard	Х	Χ	Χ	VF097AA
HP PS/2 Optical Scroll Mouse	Х	Х	Χ	EY703AA
HP USB Optical Scroll Mouse	Χ	Χ	Χ	DC172B
HP USB Laser Mouse	Х	Χ	Χ	GW405AA
DDR3 SDRAM System Memory	USDT	SFF	СМТ	Part Number
1 GB DIMM		Χ	Χ	AT023AA
1 GB SO-DIMM	Χ			TBD
2 GB DIMM		Χ	Χ	AT024AA
2 GB SO-DIMM	Χ			TBD
4 GB DIMM		Χ	Χ	TBD
4 GB SO-DIMM	Χ			TBD
HP Monitors	USDT	SFF	СМТ	Part Number
HP L1506 15 TFT Flat Panel Monitor – Analog only	Χ	Χ	Χ	PX848AA
HP L1706 17 TFT Flat Panel Monitor – Analog only	Χ	Χ	Χ	PX849AA
HP L1740 17 LCD Flat Panel Display – Analog/Digital	Χ	Χ	Χ	PL766AA
HP L1745 17 TFT Flat Panel Display – Analog/Digital	Χ	Χ	Χ	GE178AA
HP L1906 19 TFT Flat Panel Display – Analog only	Χ	Χ	Χ	PX850AA
HP L1940T 19 TFT Flat Panel Display – Analog/Digital	Χ	Χ	Χ	EM869AA
HP LP1965 19 TFT Flat Panel Display – Analog/Digital	Χ	Χ	Χ	RA373AA
HP L2045w TFT Flat Panel Display – Analog/Digital	Χ	Χ	Χ	RD125AA
HP L2065 20 TFT Flat Panel Display – Analog/Digital	Χ	Χ	Χ	EF227A4
HP LP2465 24 TFT Widescreen Flat Panel Display – Analog/Digital	Χ	Χ	Χ	EF224A4
HP LP3045 30 TFT Flat Panel Display – Digital	Χ	Χ	Χ	EZ320A8
HP w19 Wide LCD Display – Analog/Digital	Χ	Χ	Χ	EM885AA
HP s7540 17 (16.0 vis) CRT Monitor	Х	Х	Х	PF997AA
This is only representative, not an exhaustive list. All HP Monitors are supported	ed except the 30-i	nch ma	odel	



The 30-inch model can be added, but it requires a special graphics card.

After-Market Options (availability may vary by region) **USDT** SFF **CMT** Part Number Multimedia Devices HP Thin USB Powered Speakers Χ Χ Χ KK912AA DVD-ROM Drive Χ Χ AH047AA DVD-ROM Drive (Slimline) Χ FH967AA SuperMulti LightScribe Drive Χ Χ GF343AA SuperMulti LightScribe Drive (Slimline) Χ KV843AA Blu-Ray Writer Drive Χ Χ AR482AA Removable Media Storage **USDT SFF CMT** Part Number HP USB External Diskette Drive Χ Χ Χ DC141B HP Media Card Reader (22-in-1) Χ Χ AR941AA HP Media Card Reader (22-in-1) with FireWire (IEEE 1394) Χ Χ AR942AA Security Devices **USDT SFF CMT** Part Number HP/Kensington MicroSaver Cable Lock Χ Χ Χ PC766A HP Business PC Security Lock Χ Χ Χ PV606AA HP (2009) USDT Rear Port Controller Cover Χ NV571AA HP Wall Mount/Security Sleeve Χ **TBD TBD** HP ProtectTools version 5.0 (1 User) Χ Χ Χ HP USB SmartCard Keyboard Χ Χ Χ ED707AA Software Solutions **USDT** SFF **CMT** Part Number Χ HP Client Automation Standard Χ Χ T3488AA (qty 1) TA599AA (qty 10) TA600AA (qty 100) TA601AA (qty 500) T3489AA (qty 1000)



After-Market Options (availability may vary by region)

Stands and Accessories	USDT	SFF	CMT	Part Number
HP Integrated Work Center Stand	Χ			GN783AA
HP (2009) USDT Tower Stand	Χ			VN568AA
HP (2009) SFF Tower Stand		Χ		VN568AA
HP Serial Port Adapter		Χ	Χ	PA716A
HP Parallel Port Adapter		Χ	Χ	KD061AA
HP 5.25" Blank Bezel Kit (50 pack)		Χ	Χ	DC177B
HP FireWire (IEEE 1394) Card		Χ	Χ	PA997A



Technical Specifications

	Ultra-slim Desktop	Small Form Factor	Convertible Minitower
Dimensions			
Chassis	2.6 x 9.9 x 10 in	3.95 x 13.30 x 14.9 in	17.63 x 7.00 x 17.5 in
(H x W x D)	66 x 251.5 x 254 mm	100 x 338 x 378.5 mm	447.8 x 177.8 x 444.5 mm
System Volume	257.5 cu in	790.26 cu in	2160 cu in
	4.22 L	12.95 L	35.4 L
Tower Stand	1.07 x 4.92 x 6.69 in	1.12 x 7.01 x 7.87 in	N/A
(H x W x D)	27.2 x 124.9 x 169.9 mm	28.5 x 178 x 200 mm	
Packaging	8.60 x 15.68 x 19.68 in	9.00 x 19.68 x 23.38 in	22.64 x 12.72 x 24.41 in
(H x W x D)	218.4 x 398.3 x 499.9 mm	228.6 x 499.9 x 593.85 mm	575.0 x 323 x 620 mm
System Weight*	6.75 lb	16.72 lb	24.54 lb
	3.07 kg	7.6 kg	11.15 kg
Shipping Weight*	14.42 lb	17.86 lb	34.0 lb
	6.54 kg	8.1 kg	15.42 kg
Max Supported Weight (desktop orientation)	77 lb	77 lb	77 lb
	35 kg	35 kg	35 kg

I/O Ports	Ultra-slim Desktop	Small Form Factor	Convertible Minitower	
USB 2.0	Front – four (4) ports			
	Rear – six (6) ports			
Serial	N/A	one port standard; second port	available optionally	
Parallel	N/A	N/A one port available as an option		
eSATA	N/A	one port available as an option		
PS/2	color coded support for keyboar	color coded support for keyboard (purple) and mouse (green)		
Video	VGA and DisplayPort provide in	VGA and DisplayPort provide integrated dual independent monitor support		
DVI output	available via optional DisplayPc	available via optional DisplayPort to DVI Adapter		
Audio	Front – microphone & headphor	Front – microphone & headphone		
	Rear – line input (supports micro	Rear – line input (supports microphone or line input), line out		
	NOTE: See Audio/Visual section for information on re-taskable audio ports.			
NIC	Industry standard RJ-45 port acc	Industry standard RJ-45 port accesses the integrated network interface controller		

Slots	Ultra-slim Desktop	Small Form Factor	Convertible Minitower
Type and quantity	(1) mini PCI Express	(1) PCI (2) PCI Express x1 (1) PCI Express x16	(3) PCI (1) PCI Express x1 (half-length) (2) PCI Express x16
Slot specifications		Low profile cards 25W cards	Full height Primary x16 slot supports 75W or 35W card Secondary x16 slot supports 35W card Secondary slot functions electrically as a x4 slot



Technical Specifications

PCI Slots	N/A	1 slot	3 slots
		low profile – 2.5"	full height – 4.2"
		length – 6.6"	full length
		max. power – 25W	max. power – 25W
PCI Express x16 Slot	N/A	1 slot	2 slots
(Supports discrete		low profile – 2.5"	full height – 4.2"
graphics cards)		length – 6.6"	full length
		max. power –25W	max. power – 75W (primary)
			max. power – 35W (secondary)
PCI Express x1 Slot	N/A	2 slots	1 slot
· ·		low profile – 2.5"	half height – 2.5"
		length – 6.6"	half length
		max. power – 10W	max. power – 10W
Bays	Ultra-slim Desktop	Small Form Factor	Convertible Minitower
3.5" external	N/A	1 bay available for Media Card	N/A
		Reader unless used for a	
		secondary hard drive	
5.25" external	N/A	1 bay – 8.19" depth	3 bays
	<u> </u>	, '	Top two bays accept drives
			up to 8.19" depth
			Bottom bay accepts drives
			up to 5.7" depth
Slimline	1 bay for ODD	N/A	N/A
Secure Digital (SD)	SD Reader or blank	N/A	N/A
Reader		,	,
Internal Drive Bays	1 bay for 2.5" drive	1 bay for 3.5" drive	3 bays for 3.5" drives
Controller	Ultra-slim Desktop	Small Form Factor	Convertible Minitower
Hard Drive Controller	Serial ATA		
	Supports SATA 1.5-GB/s and	d 3.0-GB/s	
SATA Interfaces	(1) Total	(4) Total:	(5) Total:
		(3) common SATA	(4) common SATA
		(1) eSATA	(1) eSATA
Host SATA Controller	Advanced Host Controller In	terface (AHCI) Revision 1.2. The spec	
		terface between system software and t	

Technical Specifications

Unit Environment and Operating Conditions

General Unit Operating Guidelines

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's recirculated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.

• If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Temperature Range	Operating: 50° to 95° F (10° to 35° C)*	
	Non-operating: –22° to 140° F(–30° to 60° C)	
Relative Humidity	Operating: 10% to 90% (non-condensing at ambient)	
	Non-operating: 5% to 95% (non-condensing at ambient)	
Maximum Altitude	Operating: 10,000 ft (3048 m)	
(unpressurized)	Non-operating: 30,000 ft (9144 m)	

*Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

Power Supply	Ultra Slim Desktop	Small Form Factor	Convertible Minitower
Standard Efficiency	N/A	240W active PFC	320W active PFC
High Efficiency*	135W active PFC 87% efficient	240W active PFC 87/89/85% efficient at 20/50/100% load	320W active PFC 87/89/85% efficient at 20/50/100% load
Operating Voltage Range	90 – 264 VAC	90 – 264 VAC	90 – 264 VAC
Rated Voltage Range	100 – 240 VAC	100 – 240 VAC	100 – 240 VAC
Rated Line Frequency	50/60 Hz	50/60 Hz	50/60 Hz
Operating Line Frequency Range	47 – 63 Hz	47 – 63 Hz	47 – 63 Hz
Rated Input Current	N/A	4A	5.5A
Rated Input Current with Energy Efficient* Power Supply	2.4A	4A	5.5A
Current Leakage (NFPA 99)	< 250 μA	< 275 μA	< 450 μA
System Heat Dissipation	N/A	Typical 198 btu/hr (50 kg-cal/hr) Maximum 1063 btu/hr (268 kg-cal/hr	Typical 222 btu/hr (56 kg-cal/hr) Maximum 1410 btu/hr (356 kg-cal/hr)
System Heat Dissipation with Energy Efficient* Power Supply	Typical 133 btu/hr (33.5 kg-cal/hr) Maximum 549 btu/hr (132 kg-cal/hr)	Typical 150 btu/hr (38 kg-cal/hr) Maximum 941 btu/hr (237 kg-cal/hr)	Typical 171 btu/hr (43 kg-cal/hr) Maximum 1255 btu/hr (316 kg-cal/hr)
Power Supply Fan	N/A	92mm variable speed	92mm variable speed
External Power Adapter			
Dimensions	6.7 x 2.6 x 1.5 in	N/A	N/A



Technical Specifications

Total Cord Length	12 ft 8 in	N/A	N/A

*High efficiency power supply is a requirement for ENERGY STAR qualification in conjunction with a select range of processors and modules

ROM BIOS Information

Key features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP Elite PC into the enterprise, such as PXE, remote configuration, remote control, and F10 Setup support for 12 languages.
- Select models feature either Intel Standard Manageability or Core 2 processor with vPro Technology.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- Computrace agent For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so
 component temperatures are managed for high reliability and to assist in operating the HP Business Desktop computer in any
 enterprise environment.
- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS updates from within DOS (Flashbin), BIOS updates from within Windows (HPQFlash), HP Client Manager, and fail-safe recovery. In addition, the HP Business Desktop BIOS Utilities tool enables replicated BIOS setup throughout the Enterprise; it is available from within the BIOS software and from the support website.

Additional HP BIOS Features

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the setup password, this helps prevent unauthorized changes to the system
 configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be made
 to BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) Represents a significant innovation in power and configuration
 management, allowing operating systems and applications to manage power based on activity and usage. HP Elite models
 use ACPI to provide power conservation features.
- S5 Max Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 1W is S5 (when turned off). When S5 Max Power Savings feature is enabled power to slots is turned off along with WOL functionality.

Other Features

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode.
 Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- System Management BIOS v2.6
- Intel Wired for Management support; industry wide initiative to make Intel architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button



Technical Specifications

Serviceability Features

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
 - O Number of 1-second red LED blinks followed by a 2-second pause, then repeats:
 - 2 processor thermal protection activated
 - 3 processor not installed
 - 4 power supply failure
 - 5 memory error
 - 6 video error
 - 7 PCA failure (ROM detected failure prior to video)
 - 8 invalid ROM, bootblock recovery mode
 - 9 system not fetching code
 - 10 system hang while loading an option ROM
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacement
- Flash Recovery with Video Configuration Record Software
- 5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Dual Color Power and HD LED To Indicate Normal Operations and Fault Conditions
- Color coordinated cables and connectors
- Tool-less Hood Removal
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, CD & Diskette Removal
- Green Pull Tabs, and Quick Release Latches for easy Identification

NOTE: thumb screw release mechanism is used with the Ultra-slim Desktop chassis cover.

Additional Features	Description
Intel Standard Manageability	Includes the following:
Requires the utilization of the integrated network connection Available with selected processors, those not part of Intel's Stable Intel	Basic PC management capabilities such as asset inventory, HW alerting, SOL/IDE-R, remote configuration, agent presence, and system defense DASH 1.1 compliance for support of industry standards. Support for profile updates. Host VPN* support for local management VPN tunneling
Platform Program (SIPP) Intel Core 2 Processor with vPro	Includes the following:
Technology	Intel Advanced Management Technology (AMT) v5.0
NOTES: • Requires the utilization of the	 Intel Standard Manageability technologies (see above for a list of features) Fast Call for Help – client outside the firewall may initiate a call for help via BIOS



Technical Specifications

reclifical specifications	
 integrated network connection Available with selected processors, those part of Intel's Stable Intel Platform Program (SIPP) 	screen, periodic connections, or alert triggered connection • Audit Logs – policy based log of AMT actions to deter rogue administrator actions Microsoft NAP Support – allows AMT to gain access to a Microsoft NAP enabled 802.1x network OOB to enable OOB SW updates, inventories, remote diagnostics, etc. Remote Scheduled Maintenance – Pre-schedule when the PC connects to the IT or service provider console for maintenance
	Remote Alerts – automatically alert IT or service provider if issues arise
	Access Monitor – Provides oversight to support security requirements
DASH 1.1 support (Desktop and Mobile Architecture for System Hardware)	A standards initiative for representing out-of-band management capability for computer systems. It is a secure, web-services based successor to ASF.
ASF 2.0 support (Alert Standard Format)	Industry-standard specification for network alerting in operating system-absent environments
TXT (Trusted Execution Technology) and VT-d (Virtualized devices)	 TXT allows for secure management (via TPM) and measured launch of VMM, as well as teardown of secrets in unexpected reset case. TXT support provided in select Intel processors. VT-d is a chipset technology that virtualizes directed I/O
	Together, TXT and VT-d may be used to support verified launch of a known trusted VMM that also may protect VMs from accessing each other's memory.
Computrace	Computrace agent support standard
Tower	Product can be oriented as a tower (in addition to desktop orientation)
Drive Lock	Implementation of the industry standard ATA Security feature set. When enabled, it prevents software access to user data on the drive until one or two user-defined passwords are provided.
Drive Protection System	 A diagnostic hard drive self test. It scans critical physical components and every sector of the hard drive for physical faults and then reports any faults to the user. Running independently of the operating system, it can be accessed through a Windows-based diagnostics utility or through the computer's setup procedure. It produces an evaluation on whether the hard drive is the source of the problem and needs to be replaced.
	The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain types of failures.
SMART Technology (Self-Monitoring, Analysis and Reporting Technology)	Allows hard drives to monitor their own health and to raise flags if imminent failures were predicted
SMART I – Drive Failure Prediction	Predicts failures before they occur. Tracks fault prediction and failure indication parameters such as re-allocated sector count, spin retry count, calibration retry
SMART II – Off-Line Data Collection	count By avoiding actual hard drive failures, SMART hard drives act as "insurance"
SMART III – Off-Line Read Scanning with Defect Reallocation	 against unplanned user downtime and potential data loss from hard drive failure IOEDC: I/O Error Detection Circuitry Detects errors in Read/Write buffers on HDD cache RAM
SMART IV — End-to-End CRC for hard	



Technical Specifications

drives

Interface in F10 setup provides confirmation of SMART IV support.



Technical Specifications - Audio

High Definition Audio Integrated Type

> High Definition Stereo Codec

Yes - Realtek 4-channel ALC261 codec

Audio Jacks Front microphone-In (150-K ohm Input Impedance)

Rear Line-In/Microphone input (150-K ohm Input Impedance, function is

configurable by audio driver)

Rear Line-Out* (190 ohms Output Impedance, expects at least a 10-K ohm

load)

Front Headphone-Out (0.5 Ohm Output Impedance, expects at least a 32

ohm load)

Front Microphone/Headphone jack is re-task able to provide Microphone input, line-in or Headphone output to support connecting two headphones to the front of the system. When configured as a second front headphone output, both front headphone outputs are always driven with the same signal.

Internal Speaker Amplifier is for the internal speaker only. External speakers need to be powered externally. Rear Line-In audio port is re-task able as Line-In or Microphone-In.

Multistreaming can be enabled in the Realtek control panel to allow Multistreaming Capable

independent audio streams to be sent to/from the front and rear jacks.

8 kHz - 192 kHz Sampling

Wavetable Syntheses

Yes - Uses OS soft wavetable (software)

Analog Audio Yes

Number of Channels on Stereo (Left & Right channels)

Line-Out (mono/stereo)

Internal Audio Speaker

Power Rating

1.5 W

Internal Speaker Yes External Speaker Jack Yes

(Line-Out)



Technical Specifications - Audio

HP Thin USB Powered Speakers

On/Off/Volume Controls Right side of right speaker

Power LED Front of right speaker (green)

Frequency response FO to 20kHz

Watts 2/3 watt (normal/maximum)

Dimensions (H x W x D) Speakers: 5.72 x 3.74 x 0.96 in (14.52 x 9.50 x 2.45 cm) per speaker

Net weight 0.68 lbs (0.31kg)

Environmental Temperature (operating) 14° to 104° F (-10° to 40° C)

(all conditions Relative Humidity 40% to 90%

non-condensing) (operating)

Speaker cable length Input cord: 5.91 ft (1800mm±35mm)

L-channel cord: 3.28 ft (1000mm±35mm)

USB cord: 5.91 ft (1800mm±35mm)

Color black



Technical Specifications - Communications

Intel 82567LM Gigabit Network Connection (integrated) Connector RJ-45

Controller Intel 82567LM Gigabit platform LAN Connect Networking Controller

Memory 24 KB FIFO packet buffer memory

Data rates supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3 ab and 802.3u compliant

Bus architecture GLCI, LCI interface. Intel specific MAC to PHY interface

Data transfer mode At gigabit GLCI (Intel proprietary 802.3 series-based interface) is for Data,

LCI (parallel bus) for MDIO, at 10/100 LCI for both data and MDIO, GLCI

is idle.

Hardware certifications FCC B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark

for European Union

Power requirement Requires 3.3V,1.9/1.8V and 1.0V or just 3.3V with integrated regulators

Power consumption 1.3 Watts for 82567 whole LOM

ACBS Intel Auto Connect Battery Saving feature

Boot ROM support Yes

Network transfer mode Full-duplex

Half-duplex (not supported for the 1000BASE-T transceiver)

Network transfer rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Environmental Operating temperature 32° to 131°F (0° to 55° C)

To 70° C for external regulator

Operating humidity 85% at 131° F (55° C)

Management capabilities WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable

diagnostic.

Alerting ASF 2.0 support, AMT 3.0 support



Technical Specifications - Communications

Broadcom NetXtreme GbE Ethernet Plus NIC Connector RJ-45

Controller Broadcom 5761 PCI-Express LAN Controller

Memory 8 MB NVRAM serial Flash
Data rates supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB, 802.3u, and 802.3x

Bus architecture PCI-Express

Data path width Single Channel PCI-Express

Data transfer mode Bus Master DMA

Hardware certifications FCC class B, Canada and US NRTL Mark, C-Tick for Australia, BSMI for

Taiwan, VCCI for Japan, MIC for Korea, GOST for Russia, UL listed

(E212044), European Union Notice (CE 0682)

Power requirement 1.8W @ 3.3V

Boot ROM support Yes

Network transfer mode Full-duplex

Half-duplex (not available for the 1000BASE-T transceiver)

Network transfer rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Environmental Operating temperature 32° to 131°F (0° to 55° C)

Operating humidity 131° F (55° C) with 5% to 95% non-condensing

humidity

Dimensions 2.75 in x 4.13 in (7 cm x 10.5 cm), low profile compatible

Operating system driver Windows Vista 32-bit SP1, Windows Vista x64 SP1, Windows XP 32 bit

support professional

Management capabilities ACPI, WOL and DMI 2.0, PXE 2.0, WfM 2.0, Broadcom mgmt utility,

ASF2.0, DASH 1.0 and DASH 1.1 profiles

Technical Specifications - Communications

Intel Gigabit CT Desktop Connector

NIC

Connector RJ-45

Controller Intel 82574L Gigabit Ethernet Controller

Memory 40KB configurable transmit/receive FIFO Buffers

Data rates supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB and 802.3u compliant,

802.3x flow control, 802.1as Time synch offload

Bus architecture PCle Base 1.1 (2.5 GT/s) x1

Data path width X1, 250 MB/s, Bi-directional interface

Data transfer mode Bus-master DMA

Hardware certifications (see EPS for more certification details)

EMI: FCC Class B

Intel 25-GS3000 Environmental Specification. EN-55024: 1998 specification (see EPS for details)

EN-55022: Class A 1998 specification. EN-60950-1 first Edition specification.

C-Tick specification, Class A VCCI Class 1 specification. CE specification and CE Mark. UL 60950-1 first Edition specification. CSA 60950-1 first Edition specification. BSMI CNS13438 Class A specification Korean MIC Class A specification.

European RoHS directive China RoHS directive

Power requirement 3.3V and 3.3V Aux, 2.1 Watts max in 1000Base-T (D0)

Boot ROM support Yes

Network transfer rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps

1000BASE-T (full-duplex) 2000 Mbps (actual rate limited by PCI Bus)

Environmental Operating temperature 0 °C to 55 °C (operating)

-40 to 70 °C (non-operating)

Operating humidity 85% at 131° F (55° C)

Dimensions Low-profile, half-length form factor conforming to PCle* CEM v1.1 (55 mm

x 119 mm)

Management capabilities SMBus, WOL, PXE

HP Wireless 802.11b/g/n Dimensions (L x H)

(PCle)

H) 3.3 x 4.7 inches (8.5 x 12 cm)

Weight 0.08 pounds (40 g)
Controller Ralink RT2790
System interface PCIExpress x1
Network standard 802.11 b/g/n

Frequency band 2.400 - 2.497 GHz



Technical Specifications - Communications

Operating temperature	14° to 149°F operating (-	10° to 65°C operating		
Storage temperature	14° to 149°F, operating (-10° to 65°C, operating) -40° to 176°F, non-operating (-40° to 80°C, non-operating)			
Humidity	10-90% operating			
. romany	5-95% non-operating			
Operating voltage	3.3V +/- 9% 12V +/- 8%			
Power consumption	Platform/WLAN Mode Power Consumption			
·	Maximum Power Consumption	10 Watts		
	Transmit Only	4 Watts maximum averaged power over 1 second		
	Transmit Packet or Active Scanning	1000 mA peak current for 100 microseconds or longer		
	Receive Only Mode or Idle without IEEE PSP mode enabled	e 3 Watts maximum averaged over 1 second		
	Idle, with IEEE PSP mode enabled	1.0 Watts maximum averaged over 1 second		
	Transmit Disabled (turned off in software)	50 mW maximum, averaged over 1 second		
	Platform in S3 or S4 (power removed from Low Profile PCI Express Card)	5 mW maximum, averaged over 1 second		
Output power	802.11b modes	802.11g modes	EWC modes	
Output power (approximately)	802.11b modes +19 dBm +/- 1.0 dB	802.11g modes +17 dBm +/- 1.0 dB	EWC modes +17 dBm +/- 1.0 dB	
		-		
	+19 dBm +/- 1.0 dB	+17 dBm +/- 1.0 dB	+17 dBm +/- 1.0 dB maximum (total power	
(approximately)	+19 dBm +/- 1.0 dB maximum	+17 dBm +/- 1.0 dB maximum	+17 dBm +/- 1.0 dB maximum (total power in all transmit chains)	
(approximately)	+19 dBm +/- 1.0 dB maximum	+17 dBm +/- 1.0 dB maximum Data rate	+17 dBm +/- 1.0 dB maximum (total power in all transmit chains) Sensitivity	
(approximately)	+19 dBm +/- 1.0 dB maximum Mode 802.11b	+17 dBm +/- 1.0 dB maximum Data rate 1 Mbps	+17 dBm +/- 1.0 dB maximum (total power in all transmit chains) Sensitivity -94 dBm	
(approximately)	+19 dBm +/- 1.0 dB maximum Mode 802.11b 802.11b	+17 dBm +/- 1.0 dB maximum Data rate 1 Mbps 11 Mbps	+17 dBm +/- 1.0 dB maximum (total power in all transmit chains) Sensitivity -94 dBm -85 dBm	
(approximately)	+19 dBm +/- 1.0 dB maximum Mode 802.11b 802.11b 802.11g	+17 dBm +/- 1.0 dB maximum Data rate 1 Mbps 11 Mbps 6 Mbps	+17 dBm +/- 1.0 dB maximum (total power in all transmit chains) Sensitivity -94 dBm -85 dBm -91 dBm	
(approximately)	+19 dBm +/- 1.0 dB maximum Mode 802.11b 802.11b 802.11g 802.11g	+17 dBm +/- 1.0 dB maximum Data rate 1 Mbps 11 Mbps 6 Mbps 18 Mbps	+17 dBm +/- 1.0 dB maximum (total power in all transmit chains) Sensitivity -94 dBm -85 dBm -91 dBm -85 dBm	
(approximately)	+19 dBm +/- 1.0 dB maximum Mode 802.11b 802.11b 802.11g 802.11g 802.11g	+17 dBm +/- 1.0 dB maximum Data rate 1 Mbps 11 Mbps 6 Mbps 18 Mbps 48 Mbps	+17 dBm +/- 1.0 dB maximum (total power in all transmit chains) Sensitivity -94 dBm -85 dBm -91 dBm -85 dBm -75 dBm	
(approximately)	+19 dBm +/- 1.0 dB maximum Mode 802.11b 802.11b 802.11g 802.11g 802.11g 802.11g	+17 dBm +/- 1.0 dB maximum Data rate 1 Mbps 11 Mbps 6 Mbps 18 Mbps 48 Mbps 54 Mbps	+17 dBm +/- 1.0 dB maximum (total power in all transmit chains) Sensitivity -94 dBm -85 dBm -91 dBm -85 dBm -75 dBm -72 dBm	
(approximately)	+19 dBm +/- 1.0 dB maximum Mode 802.11b 802.11b 802.11g 802.11g 802.11g 802.11g 802.11g EWC (2.4 GHz)	+17 dBm +/- 1.0 dB maximum Data rate 1 Mbps 11 Mbps 6 Mbps 18 Mbps 48 Mbps 54 Mbps 54 Mbps 6.5 Mbps	+17 dBm +/- 1.0 dB maximum (total power in all transmit chains) Sensitivity -94 dBm -85 dBm -91 dBm -85 dBm -75 dBm -72 dBm -87 dBm	
(approximately)	+19 dBm +/- 1.0 dB maximum Mode 802.11b 802.11b 802.11g 802.11g 802.11g 802.11g 802.11g EWC (2.4 GHz) EWC (2.4 GHz)	+17 dBm +/- 1.0 dB maximum Data rate 1 Mbps 11 Mbps 6 Mbps 18 Mbps 48 Mbps 54 Mbps 6.5 Mbps 54 Mbps	+17 dBm +/- 1.0 dB maximum (total power in all transmit chains) Sensitivity -94 dBm -85 dBm -91 dBm -85 dBm -75 dBm -72 dBm -87 dBm -87 dBm	
(approximately)	+19 dBm +/- 1.0 dB maximum Mode 802.11b 802.11b 802.11g 802.11g 802.11g 802.11g 802.11g EWC (2.4 GHz) EWC (2.4 GHz)	+17 dBm +/- 1.0 dB maximum Data rate 1 Mbps 11 Mbps 6 Mbps 18 Mbps 48 Mbps 54 Mbps 54 Mbps 54 Mbps 54 Mbps 54 Mbps 51 Mbps	+17 dBm +/- 1.0 dB maximum (total power in all transmit chains) Sensitivity -94 dBm -85 dBm -91 dBm -85 dBm -75 dBm -72 dBm -87 dBm -82 dBm -82 dBm	
(approximately)	+19 dBm +/- 1.0 dB maximum Mode 802.11b 802.11b 802.11g 802.11g 802.11g 802.11g EWC (2.4 GHz) EWC (2.4 GHz) EWC (2.4 GHz) EWC (2.4 GHz)	+17 dBm +/- 1.0 dB maximum Data rate 1 Mbps 11 Mbps 6 Mbps 18 Mbps 48 Mbps 54 Mbps 6.5 Mbps 54 Mbps 81 Mbps 162 Mbps	+17 dBm +/- 1.0 dB maximum (total power in all transmit chains) Sensitivity -94 dBm -85 dBm -91 dBm -85 dBm -75 dBm -72 dBm -87 dBm -82 dBm -78 dBm -78 dBm	
(approximately)	+19 dBm +/- 1.0 dB maximum Mode 802.11b 802.11b 802.11g 802.11g 802.11g 802.11g EWC (2.4 GHz) EWC (2.4 GHz)	+17 dBm +/- 1.0 dB maximum Data rate 1 Mbps 11 Mbps 6 Mbps 18 Mbps 48 Mbps 54 Mbps 54 Mbps 54 Mbps 51 Mbps 51 Mbps 5270 Mbps	+17 dBm +/- 1.0 dB maximum (total power in all transmit chains) Sensitivity -94 dBm -85 dBm -91 dBm -85 dBm -75 dBm -72 dBm -82 dBm -82 dBm -78 dBm -78 dBm -78 dBm	
(approximately) Receive sensitivity	+19 dBm +/- 1.0 dB maximum Mode 802.11b 802.11b 802.11g 802.11g 802.11g 802.11g EWC (2.4 GHz) Data Rate (MCS) 1 Mbps (802.11 b)	+17 dBm +/- 1.0 dB maximum Data rate 1 Mbps 11 Mbps 6 Mbps 18 Mbps 48 Mbps 54 Mbps 54 Mbps 54 Mbps 51 Mbps 52 Mbps 162 Mbps 270 Mbps 300 Mbps	+17 dBm +/- 1.0 dB maximum (total power in all transmit chains) Sensitivity -94 dBm -85 dBm -91 dBm -85 dBm -75 dBm -72 dBm -82 dBm -82 dBm -78 dBm -78 dBm -78 dBm	
(approximately) Receive sensitivity	+19 dBm +/- 1.0 dB maximum Mode 802.11b 802.11b 802.11g 802.11g 802.11g 802.11g EWC (2.4 GHz) EWC (2.4 GHz)	+17 dBm +/- 1.0 dB maximum Data rate 1 Mbps 11 Mbps 6 Mbps 18 Mbps 48 Mbps 54 Mbps 54 Mbps 54 Mbps 51 Mbps 5270 Mbps 300 Mbps Minimum Throughput	+17 dBm +/- 1.0 dB maximum (total power in all transmit chains) Sensitivity -94 dBm -85 dBm -91 dBm -85 dBm -75 dBm -72 dBm -82 dBm -82 dBm -78 dBm -78 dBm -78 dBm	



Technical Specifications - Communications

11 Mbps (802.11 b)	5.9 Mbps
12 Mbps (802.11 g)	6 Mbps
18 Mbps (802.11 g)	9 Mbps
24 Mbps (802.11 g)	12 Mbps
36 Mbps (802.11 g)	18 Mbps
48 Mbps (802.11 g)	21 Mbps
54 Mbps (802.11 g)	22.5 Mbps
6.5 Mbps (20 MHz EWC)	4.5 Mbps
13 Mbps (20 MHz EWC)	9 Mbps
19.5 Mbps (20 MHz EWC)	13.5 Mbps
26 Mbps (20 MHz EWC)	18 Mbps
39 Mbps (20 MHz EWC)	27 Mbps
52 Mbps (20 MHz EWC)	36 Mbps
58.5 Mbps (20 MHz EWC)	40 Mbps
65 Mbps (20 MHz EWC)	45 Mbps
78 Mbps (20 MHz EWC)	54 Mbps
104 Mbps (20 MHz EWC)	72 Mbps
117 Mbps (20 MHz EWC)	81 Mbps
130 Mbps (20 MHz EWC)	91 Mbps
13.5 Mbps (40 MHz EWC)	8 Mbps
27 Mbps (40 MHz EWC)	16 Mbps
40.5 Mbps (40 MHz EWC)	24 Mbps
54 Mbps (40 MHz EWC)	32 Mbps
81 Mbps (40 MHz EWC)	48 Mbps
108 Mbps (40 MHz EWC)	64 Mbps
121.5 Mbps (40 MHz EWC)	72 Mbps
135 Mbps (40 MHz EWC)	81 Mbps

Security

- IEEE and WiFi compliant 64 / 128 bit WEP encryption
- AES: CCM
- 802.1x authentication
- WPA: 802.1x. WPA-PSK and TKIP
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through V5

Antenna HP part number 497792-001

Certifications Wi-Fi certified

Certifications for use by United States, Canada, Peru, Taiwan **country**



Technical Specifications - Communications

Intel WiFi Link 5100

a/b/g/n (USDT) Wireless NIC

Wireless LAN Standards IEEE 802.11a

> IEEE 802.11b IEEE 802.11g

IEEE 802.11n (draft 2.0)*

* The specifications for 802.11n draft 2.0 are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11n WLAN devices. In countries where n draft 2.0 is not allowed, this capability is not

enabled.

Wi-Fi certified (802.11abg only) Interoperability

Cisco Compatible Extensions Program compliant (802.11abg only) with

Microsoft Windows Vista and XP

Tested with wireless access points from several major manufacturers

Frequency Band Antenna Structure

Data Rates

2.4 GHz and 5 GHz 1 transmit; 2 receive (1x2)

802.11b: 1, 2, 5.5, 11 Mbps

802.11a/g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n (draft): 66 possible data rates, ranging from 6 Mbps to 300 Mbps, depending on the combination of Bandwidth, Modulation Coding Scheme, and Guard Interval used, as defined in IEEE 802.11n (draft) specification

Modulation Direct Sequence Spread Spectrum

DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM

Security¹

Sub-channels

Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES (support for key sizes of 128, 192, and 256 bits), 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2, LEAP, EAP-FAST.

Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program

Multinational support with frequency bands and channels compliant to local

Version 4) with Microsoft Windows Vista and XP only.

regulations.

CSMA/CA (Collision Avoidance) with ACK

Network Architecture Ad-hoc (Peer to Peer)

Models Infrastructure (Access Point Required)

IEEE 802.11 compliant roaming between access points Roaming

Output Power (for CCK)² 15 dBm Output Power (for OFDM; 15 dBm

power varies by data

Media Access Protocol

rate)2

Power Consumption Transmit: 2.3 Watts (average, with one spatial streams)

Receive: 1.9 Watts (average with two receive chains)

Idle mode³: 30 mW (average) Radio off: 20 mW (max)

Power Management ACPI compliant power management

802.11 compliant power saving mode

Receiver Sensitivity⁴ 300 Mbps: -68 dBm, 54 Mbps: -74 dBm, 6 Mbps: -90 dBm



Technical Specifications - Communications

Antenna Connections

Range

802.11 a - Typical
(@6 Mbps)

802.11 b - Typical

1200 feet - Outdoor Open Area
1200 feet - Outdoor Open Area

802.11 b - Typical 1200 feet - Outdoor Open Area (@1 Mbps) 300 feet - Indoor, Office environment 1200 feet - Outdoor Open Area (@1 Mbps) 1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment

Form Factor PCI-Express MiniCard

Weight 0.013 lb (6 g)

Dimensions 0.19 x 1.2 x 2.0 in (4.75 x 29.85 x 50.8 mm)

Operating Voltage 3.3V +/- 9%, 1.5V +/- 5%

Temperature Operating 32° to 176° F (0° to 80° C)
Non-operating -40° to 176° F (-40° to 80° C)

Operating 10% to 00% (non-condension)

Humidity Operating 10% to 90% (non-condensing)
Non-operating 5% to 90% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

Configuration Utility⁵ Microsoft Windows XP

Choice of Configuration Utility:

- Microsoft Windows XP Wireless Network Connection Manager
- Intel PROSet for Microsoft Windows XP (required for Cisco Compatible Extensions support)

Microsoft Windows Vista

- Microsoft Windows Vista Wireless Network Connection Manager.
- Intel IHV extensions for Windows Vista available to support Cisco Compatible Extensions.
- 1. Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.
- 3. In Power Save Polling mode and on battery power.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
- WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista.

LSI PCle x1 56K International SoftModem

Data Transmission Technology speeds: 56,000 Kbps maximum downstream data, controllerless

NOTE: 56 Kbps technology refers to download speeds only and requires compatible modems at server sites. Other conditions may limit modem speed. FCC limitations allow a maximum of 53 Kbps during download

transmissions.

Data Speeds (Upload only) 33,600/31,200/28,800/26,400/21,600/19,200/

16,800/14,400/12,000/9,600/7,200/4,800/2,400/1,200/300



Technical Specifications - Communications

Data Standards ITU-T V.90, ITU-T, ITU-T V.34, V.44, V.42, V.42bis21, V.32bis, Bell 212A,

and Bell 103

Fax Speeds 14,400/12,000/9,600/7,200/4,800/2,400/1,200/300 b/s

Fax Mode Capabilities Error Correction and Data Compression ITU-T T.31 class 1 FAX, V. 17, V.29, V.27ter, and V.21 Channel 2

on and V.44, 42bis, V.42 and MNP2-5

Power Management PCI Bus Power Management Interface Specification (PCI-PM) Revision 1.2,

Appendix A. D0, D3hot, and D3cold. Wake on Ring state when in D3cold. If the power management event (PME) feature is enabled in D3cold, a modem can wake the system via WAKE# (WAKEN) or beacon. Meets PCI Express

1.1 standard.

Upgradeability Driver upgradeable for future enhancements

Video ITU-T V.80 video ready interface

Other TIA/EIA 602 standard AT command set

Integrated DTE interface with speeds of up to 115.2 Kbps, parallel 16550a

UART-compatible interface

Optional ring wakeup signal 32° to 158° F (0° to 70° C)

Operating Temperature 32° to 158° F (0° to 70° C)
Operating Humidity 20% to 90%, non-condensing

Power Requires a 3.3-V auxiliary power rail on PCI express bus

Uses only one PCI express load (i.e., one grant/request pair), one shared

IRQ, one electrical load

Chipset LSI SV92EX - Integrated PCI interface with 3.3-V tolerant buffers and

CardBus support

Dimensions (L X H) Complies with PCI express low profile specifications-6.7 x 2.3 in (17.0 x 5.8

cm) and supports high- and low-profile brackets

Connection Single RJ-11 connector

Other Features Digital line protection, call progress monitoring via on-board piezo device,

support for high profile and low profile brackets, PnP ID support

Safety UL recognized to UL 1950, 3rd edition (U.S. and Canada); IEC 950 (TUV,

NEMKO, DEMKO, SEMKO); CE Mark, EC 950 (TUV, NEMKO, DEMKO,

SEMKO, CE mark

EMC FCC Part 15, IC ES003, EN 55022, 3rd edition, EN 55024, annex A, EN

61000-4-6, EN 61000-4-8

Telecom FCC Part 68, IC-CS-03 (Canada); Worldwide PTT approvals

Not available in Korea or the Republic of South Africa.

Other The SV92EX device is packaged in a 32-pin micro leadless chip carrier

(MLCC). The SV92EX is fully compliant with the PCI Express revision 1.1

specification. WHQL approved; ASPM compliant.

Technical Specifications - Graphics

Integrated Intel Graphics Media Accelerator (GMA) 4500 3D/2D Controller VGA Controller DisplayPort Bus Type RAMDAC

Memory

Microsoft DirectX® 10 based with support for Pixel Shader 3.0

Integrated

Integrated, Multimode capable; supports HDCP

PCI Express™ x16 Integrated, 350 MHz

Graphics memory is shared with system memory. Graphics memory usage varies depending on the amount of system memory installed, BIOS settings, operating system, and system load. 32 MB is pre-allocated for graphics use at system boot time. Additional memory can be allocated at boot time by the BIOS for PAVP (Protected Audio Video Playback) support for playback of protected video content. For Vista, use of PAVP heavy mode preallocates an additional 96MB.

Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory use.

Windows XP Memory Usage:

Total System Memory	Pre-Allocated (MB)	DVMT (MB)		
.5GB	32	128		
1.0GB	32	512		
1.5GB	32	768		
2GB & more	32	1024		

Windows Vista Memory Usage:

(Assumes Management Engine , VT-d enabled and other memory allocated for other BIOS usage)

System Memory	PVAP	Avail System Memory (MB)	Total Avail GFX Memory (MB)	Dedicated Video Memory (MB)	System Video Memory (MB	Shared System Memory (MB)
1.05	Lite	952	252	32	96	124
1 GB	Heavy	856	294	122	6	166
I 2 GB	Lite	1976	764	32	96	636
	Heavy	1880	806	122	6	678
4 GB	Lite	4024	1759	32	96	1631
4 GB H	Heavy	3928	1759	122	6	1631
I 6GB ⊫	Lite	6072	1759	32	96	1631
	Heavy	5976	1759	122	6	1631
18G8 1	Lite	8120	1759	32	96	1631
	Heavy	8024	1759	122	6	1631

Total Available GFX Memory: Total graphics memory available to the system as reported by the OS.

Dedicated Video Memory: Memory owned and locked for graphics use as reported by the OS. (Preallocated)

System Video Memory: System memory locked and dedicated for graphics use.



Technical Specifications - Graphics

Shared System Memory: Memory dynamically allocated for Graphics use

HW Video Decode Hardware Accelerated decode for MPEG2 encrypted video; support for PAVP Lite

(default) and Heavy (or Paranoid) modes

Maximum Color Depth

32 bits/pixel

Maximum Vertical Refresh Rate 85 Hz at up to 1920x1440, 75 Hz at 2048x1536. Varies with mode and

configuration. See table below.

Multi-display Support Integrated dual independent monitor support facilitated via one VGA port and one

DisplayPort integrated on the back plane of the system board and presented as part of the rear I/O set of interfaces. DVI supported via optional HP DisplayPort to DVI-D

adapter.

Graphics/Video API

Support

Microsoft DirectX® 10, OpenGL® 1.5 (OpenGL® 2.0 available in a driver update)

Resolutions Supported

NOTE: Other resolutions may be available but are not recommended as the may not have been tested and qualified by HP.

	Maximum Refresh Rate (Hz)		
Resolution	Analog Connection	Digital Connection	
640x480	85	60	
800x600	85	60	
1024x768	85	60	
1280x720	85	60	
1280x1024	85	60	
1440x900	75	60	
1600x1200	85	60	
1680x1050	75	60	
1920x1080	85	60-R	
1920x1200	85	60-R	
1920x1440	85	N/A	
2048x1536	75	N/A	
2560x1600	N/A	60*	

^{*} Only supported when using a DisplayPort connection

NOTE: 60-R denotes reduced blanking timings are used on single-link DVI connections and may be used with other digital connections.



Technical Specifications - Graphics

NVIDIA Quadro NVS 290 Form Factor 256MB PCle Dual Head

Low Profile **Bus Type** PCle x16

Memory 256 MB 400MHz DDR2 SDRAM unified frame buffer, Z-buffer and Texture

storage

Connector DMS-59; includes one DMS-59 to Dual VGA cable. A DMS-59 to Dual DVI-

I cable is available as an option.

Display resolution support Dual integrated analog display controllers supporting up to two analog

displays at 2048x1536 @ 85Hz on both displays or dual digital displays at

1920x1200 (single-link).

NVIEW advanced multi-display desktop and application management

seamlessly integrated into Microsoft Windows

RAMDAC Integrated dual 400MHz

Color planes 32-bit color buffer Overlay planes Hardware supported

nView architecture Advanced multi-display desktop & application management seamlessly

integrated into Microsoft Windows.

Multi-Monitor support

DVI support DMS-59 (to dual DVI-SL)

High-definition Video

Processor (HDVP)

Full-screen, full-frame video playback of HDTV and DVD content

DVD-ready motion compensation for MPEG-2

Independent hardware color controls for video overlay Hardware color-space conversion (YUV 4:2:2 and 4:2:0)

IDCT motion compensation

5-tap horizontal by 3-tap vertical filtering

8:1 up/down scaling

Dual monitor support

Supported graphics APIs OGL 2.1 & DX10 Support; Shader Model 4.0

NVIDIA Quadro NVS 295 Form Factor

Graphics Card

Graphics Controller

2.731 inches (H) \times 6.600 inches (L), Half-Height

NVIDIA Quadro NVS 295 Graphics Board

Bus Type PCI Express x16, Generation 2.0

Memory 256 MB GDDR3 SDRAM unified graphics memory

Connectors 2 DisplayPort

Comes with 2 DisplayPort to DVI-D Adapters

('DisplayPort to VGA' and 'DisplayPort to DL DVI' adapters available as an

accessory)

Maximum Resolution

Display Output

Two DisplayPort outputs drive two digital displays up to 2560 x 1600

• Drives DisplayPort enabled digital displays at resolutions up to 2560

 \times 1600 at 60 Hz with reduced blanking

Drives DVI enabled digital displays at resolutions up to 1920×1200 at 60 Hz with reduced blanking (through DisplayPort to DVI-D (single link) cable)

Supported Graphics APIs OpenGL 3.0

DirectX 10.0



Technical Specifications - Graphics

NVIDIA GeForce 310 DP PCle x16 **Graphics Card**

Bus type PCI Express (x16 lanes)

Maximum vertical refresh rate

85 Hz

Display support

Integrated 400 MHz RAMDAC

Display max resolution 2560x1600 digital, 2048 x 1536 analog

NVIDIA GeForce 310 DP PCle x16 Graphics Card display resolutions and refresh rates

NOTE: Other resolutions may be available but are not recommended as the may not have been tested and qualified by HP.

<u> </u>	<u> </u>	
Maximum Refresh Rate (Hz)		
Analog Connection	Digital Connection	
85	60	
85	60	
85	60	
85	60	
85	60	
75	60	
85	60	
75	60	
85	60-R	
85	60-R	
85	N/A	
75	N/A	
N/A	60*	
	Analog Connection 85 85 85 85 85 75 85 75 85 75 85 75	

^{*} Only supported when using a dual-link DVI or DP connection.

NOTE: 60-R denotes reduced blanking timings are used on single-link DVI connections and may be used with other digital connections

Board display options

Supports two displays via the DisplayPort and DVI connectors

Board configuration

Specification Description Graphics Chip RV620 Core clock 750 MHz Memory clock 500 MHz

Frame buffer 512 MB DDR3, 64 bit wide

Audio Support (through

HDMI only)

Integrated HD Audio codec supports linear PCM and Dolby® Digital (7.1) audio

formats for HDMI output

Operating systems support

Windows 7 Home Basic*, Windows 7 Home Premium*, Windows 7 Professional Edition 32*, Windows 7 Professional Edition 64*, Windows 7 Ultimate Edition 32*, Windows 7 Ultimate Edition 64*, Windows Vista Business 32†, Windows Vista Business 64†, Windows Vista Home Basic 32†, Windows Vista Home Basic 64†, Windows XP Professional or Windows XP Home 32+.

*This system may require upgraded and/or separately purchased hardware and/or a DVD drive to install the Windows 7 software and take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

Windows 7 Business disk may be included for future upgrade if desired. To qualify for this downgrade an end user must be a business (including governmental or educational institutions) and is expected to order at least 25 customer systems with the



Technical Specifications - Graphics

same custom image

† Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit:

http://www.windowsvista.com/upgradeadvisor. For Windows Vista system requirements, visit: http://www.windowsvista.com/systemrequirements.

Linux x86 and x86 64 distributions using XFree86 or X.Org‡.

‡Linux drivers are available from ATI's website and may be available in a Linux distribution. Refer to the Open Source and Linux from HP website:

http://www.hp.com/wwsolutions/linux/products/clients/ for support information.

Core power

22 W (max)

Dimensions (H x D)

2.71 in x 6.60 in (68.90 mm x 167.65 mm)

Weight

0.30 lb (134.3 g)

Option kit contents

- NVIDIA GeForce 310 DP PCle x16 Graphics Cardwith full height bracket attached
- DVI to VGA adapter
- Software CD with graphics drivers
- Low profile bracket to convert the card for using in a low profile chassis
- Warranty documentation

Compliance standards

EMC Emissions:

a) FCC Part 15, Subpart B - Unintentional Radiators, Class B Computing Devices for Home & Office Use

b) CISPR22: 1997/EN 55022:1998 - Class B - Limits and methods of measurement of radio disturbance characteristics of Information Technology Equipment

- c) Canadian Standard ICES-003 is equivalent to CISPR22
- d) Taiwanese Standard BSMI
- e) Japanese VCCI
- f) Australian C-Tick
- g) Korean (MIC)

EMC Immunity:

CISPR 24:1997/EN 55024:1998 - Information Technology Equipment - Immunity Characteristics - Limits and Methods of Measurement.

ATI Radeon HD 4550 Dual Head PCle x16 Graphics Card Bus type PCI Express (x16 lanes)

Maximum vertical refresh rate 85 Hz

Display support Integrated 400 MHz RAMDAC

Display max resolution 1900 x 1200 digital, 2048 x 1536 analog

Board display options Supports two displays via included DMS-59 to dual VGA cable or 2 DVI

monitors via optional DMS-59 to dual DVI cable kit part number:

DL139A. 4-pin mini-DIN S-video connector for TV output



Technical Specifications - Graphics

Board configuration	Specification	Description
	Graphics Chip	RV710
	Core clock	600MHz
	Memory clock	800 MHz

Frame buffer 256 MB DDR2, 64 bit wide

Languages supported 24 languages: English, Arabic, Chinese Simplified, Chinese Traditional,

Czechoslovakian, Danish, Dutch, Finnish, French, German, Greek, Hebrew, Hungarian, Italian, Japanese, Korean, Norwegian, Polish,

Portuguese, Russian, Spanish, Swedish, Thai, Turkish

Compliance standards EMC Emissions:

a) FCC Part 15, Subpart B - Unintentional Radiators, Class B Computing

Devices for Home & Office Use

b) CISPR22: 1997/EN 55022:1998 - Class B - Limits and methods of measurement of radio disturbance characteristics of Information

Technology Equipment

c) Canadian Standard ICES-003 is equivalent to CISPR22

d) Taiwanese Standard BSMI

e) Japanese VCCI

f) Australian C-Tick

g) Korean (KCC)

EMC Immunity:

CISPR 24:1997/EN 55024:1998 - Information Technology Equipment - Immunity Characteristics - Limits and Methods of Measurement.

ATI Radeon HD 4550 DH PCle x16 Graphics Card display resolutions and refresh rates

NOTE: Other resolutions may be available but are not recommended as the may not have been tested and qualified by HP.

Resolution	Maximum Refresh Rate (Hz)		
	Analog Connection	Digital Connection	
640x480	85	60	
800x600	85	60	
1024x768	85	60	
1280x720	85	60	
1280x1024	85	60	
1440x900	75	60	
1600x1200	85	60	
1680x1050	75	60	
1920x1080	85	60-R	
1920x1200	85	60-R	
1920x1440	85	N/A	
2048x1536	75	N/A	
2560x1600	N/A	N/A	

NOTE: 60-R denotes reduced blanking timings are used on single-link DVI connections and may be used with other digital connections.

ATI Radeon HD 4650

Bus type

PCI Express (x16 lanes)



Technical Specifications - Graphics

(1GB) PCle x16 Graphics Maximum vertical refresh rate 85 Hz

Card

Display support Integrated 400 MHz RAMDAC

Display max resolution 2560 x 1600 digital, 2048 x 1536 analog

Board display options Supports two displays through any combination of two of the three output

ports.

Board configuration Specification Description

> Graphics Chip RV730Pro Core clock 600MHz Memory clock 500 MHz

Frame buffer 1 GB DDR3, 128 bit wide

55 W Maximum power

Languages supported 24 languages: English, Arabic, Chinese Simplified, Chinese Traditional,

> Czechoslovakian, Danish, Dutch, Finnish, French, German, Greek, Hebrew, Hungarian, Italian, Japanese, Korean, Norwegian, Polish,

Portuguese, Russian, Spanish, Swedish, Thai, Turkish

EMC Emissions: Compliance standards

a) CISPR22: 1997/EN 55022:1998 - Class B - Limits and methods of measurement of radio disturbance characteristics of Information

Technology Equipment

EMC Immunity:

CISPR 24:1997/EN 55024:1998 - Information Technology Equipment -Immunity Characteristics - Limits and Methods of Measurement.

ATI Radeon HD 4650 (512MB) PCle x16 Graphics Card display resolutions and refresh rates

NOTE: Other resolutions may be available but are not recommended as the may not have been tested and qualified by HP.

Resolution	Maximum Refresh Rate (Hz)		
	Analog Connection	Digital Connection	
640x480	85	60	
800x600	85	60	
1024x768	85	60	
1280x720	85	60	
1280x1024	85	60	
1440x900	75	60	
1600x1200	85	60	
1680x1050	75	60	
1920x1080	85	60-R*	
1920x1200	85	60-R	
1920x1440	85	N/A	
2048x1536	75	N/A	
2560x1600	N/A	60**	

Max HDMI resolution is 1080p

NOTE: 60-R denotes reduced blanking timings are used on single-link DVI connections and may be used with other digital connections



^{**} Only supported when using a dual-link DVI connection

Technical Specifications - Graphics

HP ADD2 SDVO PCIe DVI-D Adapter Models HP ADD2 SDVO DVI-D Out Adapter

Form Factor Low-profile card

DVI-D Connector Digital connection only

Dual Head SupportYes, when used with the integrated VGA connector

Display Devices HP L1740 Supported HP L1940T HP L2045W

HP L2045W HP LP1965

NOTE: These graphics adapters offer optimal performance with any display that meets applicable VESA

standards.

Color Depth All modes support 8-bpp, 16-bpp, and 24-bpp color depths

Host Interface Connector Mechanically compliant with PCI-E standard

Complies with the Intel ADD2 and Intel Serial Digital Video Output (SDVO)

specifications

Dot Clock 165 MHz maximum

Display Modes Supports display modes that require up to 165-MHz bandwidth on the link,

as shown in the following table.

Reso	lution	60-Hz LCD	60-Hz	75-Hz	85-Hz
Blar	nking	5% reduced	GTF	GTF	GTF
640 x 480	VGA	Yes	Yes	Yes	Yes
800 x 600	SVGA	Yes	Yes	Yes	Yes
1024 x 768	XGA	Yes	Yes	Yes	Yes
1280 x 1024	SXGA	Yes	Yes	No	No
1600 x 1200	UXGA	Yes	Yes	No	No

HP DisplayPort to DVI-D Adapter

Connectors

DisplayPort and DVI-D single link connector

Adapter length
Adapter weight

7.5 in (19.0 cm) .10 lbs (.05 kg)

Technical Specifications - Graphics

HP DisplayPort to VGA

Connectors

DisplayPort and VGA connector

Adapter

Adapter length 8 in (20 cm)
Adapter weight .1 lbs (.06 kg)

Maximum vertical refresh rate 85 Hz

Display support 162 MHz RAMDAC

Display max resolution 1600x1200

HP DisplayPort to VGA adapter display resolutions and refresh rates

NOTE: Other resolutions may be available but are not recommended as they may not have been tested and qualified by HP. Using the HP DisplayPort to VGA Adapter may require an update to the graphics driver installed on your system. To install the most up-to-date graphics driver go to: www.hp.com.

Resolution	Max refresh rate
640x480	85
800x600	85
1024x768	85
1280x720	85
1280x1024	85
1440x900	75
1600x1200	60
1680x1050	60
1920x1080	60-R
1920x1200	60-R
NOTE: 60-R denotes reduced blanking timings are used. Not all monitors support reduced blanking timing.	



Technical Specifications - Hard Drives

2.5" 7200 RPM Serial 250 GB 250,059,350,016 bytes Capacity ATA Hard Drives Height (Nominal) 0.374 in (9.5 mm)

> Width (Nominal) Media diameter: 2.5 in (63.5 mm)

> > Physical size: 2.75 in (70 mm)

Interface Serial ATA (3.0 Gb/s)

Synchronous Transfer Rate Up to 3 Gb/s

(Maximum)

Cache 8 MB

Seek Time (typical reads, Single Track 2.0 ms includes controller Average 12 ms overhead, including Full-Stroke 22 ms settling)

Rotational Speed 7,200 rpm 488,397,168 Logical Blocks

41° to 131° F (5° to 55° C) **Operating Temperature**

160 GB Capacity 160,041,885,696 bytes

> Height (Nominal) 0.374 in (9.5 mm)

Media diameter: 2.5 in (63.5 mm) Width (Nominal)

Physical size: 2.75 in (70 mm)

Interface Serial ATA (3.0 Gb/s)

Synchronous Transfer Rate Up to 3 Gb/s

(Maximum)

Cache 8 MB

Seek Time (typical reads, Single Track 2.0 ms includes controller Average 12 ms overhead, including Full-Stroke 22 ms settling)

7,200 rpm Rotational Speed

Logical Blocks 312,581,808

41° to 131° F (5° to 55° C) Operating Temperature

3.5" 7200 RPM Serial 500 GB Capacity 500,107,862,016 bytes **ATA Hard Drives**

Height 1 in (2.54 cm)

Width Media diameter: 3.5 in (8.89 cm)

Physical size: 4 in (10.2 cm)

Interface Serial ATA (3.0 Gb/s)

Synchronous Transfer Rate Up to 3 Gb/s

(Maximum)

Buffer 16 MB



Technical Specifications - Hard Drives

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average2.0 msAverage
Full-Stroke11 ms21 ms

Rotational Speed 7,200 rpm Logical Blocks 976,773,168

Operating Temperature 41° to 131° F (5° to 55° C)

320 GB Capacity 320,069,031,690 bytes

Height 1 in (2.54 cm)

Width Media diameter: 3.5 in (8.89 cm)

Physical size: 4 in (10.2 cm)

Interface Serial ATA (3.0 Gb/s)

Synchronous Transfer Rate Up to 3 Gb/s

(Maximum)

Buffer 8 MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average1.0 msAverage
Full-Stroke8.5 ms18 ms

Rotational Speed 7,200 rpm Logical Blocks 625,142,448

Operating Temperature 41° to 131° F (5° to 55° C)

250 GB Capacity 250,059,350,016 bytes

Height 1 in (2.54 cm)

Width Media diameter: 3.5 in (8.89 cm)

Physical size: 4 in (10.2 cm)

Interface Serial ATA (3.0 Gb/s)

Synchronous Transfer Rate Up to 3 Gb/s

(Maximum)

Buffer 8 MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average1.0 msAverage
Full-Stroke8.5 ms18 ms

Rotational Speed 7,200 rpm Logical Blocks 488,397,168

Operating Temperature 41° to 131° F (5° to 55° C)

160 GB Capacity 160,041,885,696 bytes

Height 1 in (2.54 cm)



Technical Specifications - Hard Drives

Width Media diameter: 3.5 in (8.89 cm)

Physical size: 4 in (10.2 cm)

Interface Serial ATA (3.0 Gb/s)

Synchronous Transfer Rate Up to 3 Gb/s

(Maximum)

Buffer 8 MB

Seek Time (typical reads, Single Track 0.9 ms includes controller 9.3 ms Average overhead, including Full-Stroke 18 ms

settling)

Rotational Speed 7,200 rpm Logical Blocks 312,581,808

41° to 131° F (5° to 55° C) **Operating Temperature**

10,000 RPM Serial ATA 160 GB

Hard Drives

160,041,885,696 bytes Capacity

Height 1 in (2.54 cm)

Width Media diameter: 3.0 in (7.62 cm)

Physical size: 4 in (10.2 cm)

Serial ATA (1.5 Gb/s), Native Command Queuing Interface

enabled

Up to 3.0 Gb/s

Synchronous Transfer

Rate (Maximum)

Cache 16 Mbytes

0.3 ms Seek Time (typical reads, Single Track includes controller Average 4.6 ms overhead, including Full-Stroke 10.2 ms settling)

Rotational Speed 10,000 rpm

Logical Blocks 312,581,808

Operating Temperature 41° to 131° F (5° to 55° C)

Technical Specifications - Hard Drives

Solid State Drive 64 GB Capacity 64 GB

> NAND Flash Memory Multi Level Cell (MLC) with wear leveling controller

Interface type SATA 3Gb/sec

Dimensions-external

 $(W \times H \times D)$

 $2.74 \times 0.37 \times 4$ in $(6.98 \times 0.95 \times 10.2 \text{ cm})$

Weight 0.14 lb (65 g)

Internal transfer rate Write speed Up to 220 MB/s

> Read speed Up to 120 MB/s

Host transfer rate Ultra DMA mode Up to 150 MB/s

Power DC power requirement 5 VDC 5%-100 mV ripple p-p

Total power consumption <1.12Watt

Environmental **Temperature** (operating) 32° to 158° F (0° to 70° C)

(all conditions, non-Relative Humidity 5% to 95% condensing)

(operating)

Maximum Wet Bulb 84° F (29° C)

Temperature (operating)

UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS Regulations

13438, AS/NZS CISPR 22:2002 Class B, R1113 and

C1172 Class B

NOTE: For solid state disk drives, GB means 1 billion bytes. 16GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity varies by content and will be less than 15.8GB.



104, 105, 106, 107, 109 layout (depending

QuickSpecs

USB Standard Keyboard

Technical Specifications - Input/Output Devices

Physical

characteristics		upon country)
	Dimensions $(L \times W \times H)$	18.0 x 6.4 x 0.98 in (45.8 x 16.3 x 2.5 cm)
	Weight	2 lb (0.9 kg) minimum
Electrical	Operating voltage	+ 5VDC ± 5%
	Power consumption	50-mA maximum (with three LEDs ON)
	System interface	USB Type A plug connector
	ESD	CE level 4, 15-kV air discharge
	EMI - RFI	Conforms to FCC rules for a Class B computing device
	Microsoft® PC 99 - 2001	Functionally compliant
Mechanical	Languages	38 available
	Keycaps	Low-profile design
	Switch actuation	55-g nominal peak force with tactile feedback
	Switch life	20 million keystrokes (using Hasco modified tester)
	Switch type	Contamination-resistant switch membrane
	Key-leveling mechanisms	For all double-wide and greater-length keys
	Cable length	6 ft (1.8 m)

Keys

Environmental Operating temperature

Non-operating -22° to 140° F (-30° to 60° C)

temperature

Acoustics

Microsoft PC 99 - 2001

Operating humidity 10% to 90% (non-condensing at ambient)
Non-operating humidity 20% to 80% (non-condensing at ambient)

Mechanically compliant

50° to 122° F (10° to 50° C)

43-dBA maximum sound pressure level

Operating shock40 g, six surfacesNon-operating shock80 g, six surfacesOperating vibration2-g peak accelerationNon-operating vibration4-g peak acceleration

Drop (out of box)

26 in (66 cm) on carpet, six-drop sequence

Drop (in box)

42 in (107 cm) on concrete, 16-drop sequence

Approvals

UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC

Ergonomic compliance ANSI HFS 100, ISO 9241-4, and TUVGS

Kit contents Keyboard, installation guide, warranty card, safety and comfort guide

Technical Specifications - Input/Output Devices

PS/2 Standard Keyboard	itandard Keyboard Physical I characteristics		104, 105, 106, 107, 109 layout (depending upon country)	
		Dimensions $(L \times W \times H)$	18.0 x 6.4 x 0.98 in (45.8 x 16.3 x 2.5 cm)	
		Weight	2 lb (0.9 kg) minimum	
	Electrical	Operating voltage	$+$ 5VDC \pm 5%	
		Power consumption	50-mA maximum (with three LEDs ON)	
		System interface	PS/2 6-pin mini din connector	
		ESD	CE level 4, 15-kV air discharge	
		EMI - RFI	Conforms to FCC rules for a Class B computing device	
		Microsoft PC 99 - 2001	Functionally compliant	
	Mechanical	Languages	38 available	
		Keycaps	Low-profile design	
		Switch actuation	55-g nominal peak force with tactile feedback	
		Switch life	20 million keystrokes (using Hasco modified tester)	
		Switch type	Contamination-resistant switch membrane	
		Key-leveling mechanisms	For all double-wide and greater-length keys	
		Cable length	6 ft (1.8 m)	
		Microsoft PC 99 - 2001	Mechanically compliant	
		Acoustics	43-dBA maximum sound pressure level	
	Environmental	Operating temperature	50° to 122° F (10° to 50° C)	
		Non-operating temperature	-22° to 140° F (-30° to 60° C)	
		Operating humidity	10% to 90% (non-condensing at ambient)	
		Non-operating humidity	20% to 80% (non-condensing at ambient)	
		Operating shock	40 g, six surfaces	
		Non-operating shock	80 g, six surfaces	
		Operating vibration	2-g peak acceleration	
		Non-operating vibration	4-g peak acceleration	
		Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence	
		Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence	
	Approvals	UL, CSA, FCC, CE Mark,	TUV, TUV GS, VCCI, BSMI, C-Tick, MIC	
	Ergonomic compliance	ANSI HFS 100, ISO 9241	-4, and TUVGS	
HP USB Smartcard Keyboard	Physical characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)	
		Form factor	USB basic Smart Card keyboard	
		Colors	Carbonite/Silver	
		Dimensions (H \times W \times D)	18.2 x 6.3 x 1.3 in (46.3 x 16.1 x 3.3 cm)	
		Weight	2 lb (0.9 kg) minimum	
			_,	

Electrical

+ 5VDC \pm 5%

Operating voltage

Technical Specifications - Input/Output Devices

Power consumption 100-mA maximum (with four LEDs ON)

System interface USB Type A plug connector ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing

device

Microsoft PC 99 - 2001 Functionally compliant

MechanicalLanguages30+ available

Keycaps Low-profile design

Switch actuation 55 g nominal peak force with tactile feedback Switch life 20 million keystrokes (using Hasco modified

tester)

Switch type Contamination-resistant membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Environmental Operating temperature 50° to 122° F (10° to 50° C)

Non-operating -22° to 140° F (-30° to 60° C)

temperature

Operating humidity 10% to 90% (non-condensing at ambient)
Non-operating humidity 20% to 80% (non-condensing at ambient)

Operating shock40 g, six surfacesNon-operating shock80 g, six surfacesOperating vibration2-g peak accelerationNon-operating vibration4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 42 in (107 cm) on concrete, 16-drop sequence

SMARTCARD function Support All ISO 7816 smart cards

Interface Reads from and writes to all ISO7816-1, 2, 3, 4

memory and microprocessor smart cards (T=0,

T=1

Chipset SCM STCII

Standard APIs supported PC/SC, EMV2000, SET

Power USB Port

Short circuit detection (protects smart card and

reader)

Power supply compliant with ISO7816 and EMV

(5V, 60 mA)

Supports 3-V and 5-V cards

Power consumption 250-mA maximum draw (50 mA for the

keyboard with three LEDs ON and 200-mA maximum startup current using a high-current,

60-mA smart card)



Technical Specifications - Input/Output Devices

rechnical specifical	ions - inpui/Ouipui D	evices			
		Communication	From card	Programmable from 9,600 baud to 115,200 baud	
			From computer	Up to 38,400 baud	
		Landing mechanism	Contact device	Friction contact	
		-	Card insertions rating	Up to 100,000 insertion cycles	
		Interface modes	USB communications the SCM protocol Automatic card insertio		
		Reader performance interface	USB connection		
		Electro-magnetic	Europe	89/336/CEE guideline	
		standards	USA	USAFCC part 15	
HP PS/2 Optical Scroll	Dimensions (H \times L \times W)	3.95 x 6.21 x 11.7 cm (1	.56 x 2.44 x 4.61 in)		
Mouse	Weight	4.44 oz (126 g)			
	Environmental	Operating temperature	-32° to 104°F (0° to 40° C)		
		Non-operating temperature	-4° to 140°F (-20° to 60° C)		
		Operating humidity	10% to 90% (non condensing at ambient)		
		Non-operating humidity	10% to 90% non conde	ensing	
		Operating shock	40 g, 6 surfaces		
		Non-operating shock	80 g, 6 surfaces		
		Operating vibration	2 g peak acceleration		
		Non-operating vibration	4 g peak acceleration		
		Drop (out of box)	• .	nalt tile over concrete or direction except the cable	
	Electrical	Operating voltage	5 VDC ± 10%		
		Power consumption	100mA		
		System consumption	PS/2 mini-din connecto	or	
		ESD	CE level 4, 15 kV air di	ischarge	
		EMI-RFI	Conforms to FCC rules device	for a Class B computing	
		Microsoft PC99 - 2001	Functionally compliant		
	Mechanical	Resolution	400 ± 20% DPI		
		Tracking speed	10 in/s (25.4 cm/s) mo	ıximum	
		Acceleration	100 in/s/s (2.54 m/s/s		
		C 11 1 11	/1		

Switch actuation

Switch life

Switch type

61 g nominal peak force

Low force micro-switches

tester)

3,000,000 operations (using Hasco modified

Technical Specifications - Input/Output Devices

Tracking mechanism life 155 mi (250 km) at average speed of 10 in/s

Cable length 6 ft (1.8 m)

Microsoft PC99 - 2001 Mechanically compliant

Scroll wheel Width 8 mm

Diameter 1.01 in (25.6 mm)

Maximum rotation speed 48 rats/sec

Switch type Light force micro-switch
Switch life 1 million operations

Mechanical life Minimum 200,000 revolutions

Regulatory approvals Compliant UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI,

BSMI, C-Tick, MIC

HP USB Optical Scroll

Mouse

Dimensions (H x L x W) 1.5 x 4.5 x 2.5 in (3.8 x 11.6 x 6.3 cm)

 Weight
 0.27 lb (0.12 kg)

 Cable length
 72.8 in (185 cm)

System requirements Microsoft Windows 95, 98, 2000, Me, XP and Vista

Available USB port

HP USB 2-Button Laser

Mouse

Scroll Wheel 24

Maximum Rotation Speed 48 rats/sec Switch Type wheel

Switch Life Button - 3,000,000

Wheel - 1,000,000 times Tilt switch - 500,000 times

Environmental Operating Temperature 32° to 104° F (0° to 40° C)

Non-operating -4° to 140° F (-20° to 60° C)

Temperature

Operating Humidity 10% to 90% (non-condensing at ambient)
Non-operating Humidity 20% to 80% (non-condensing at ambient)

Operating Shock40 g, six surfacesNon-operating Shock80 g, six surfacesOperating Vibration2-g peak accelerationNon-operating Vibration4-g peak acceleration

Electrical Operating Voltage $+ 5VDC \pm 5\%$

Power Consumption

MTBF > 150,000 hrs

ESD IEC-61000-4-2 criteria B, Contact discharge:

+/- 4kV, Air discharge: +/- 8kV

EMI-RFI FCC Class B **PC98** PC 99 Compliant

Mechanical Resolution 800dpi

Tracking Speed 25 cm/sec



Technical Specifications - Input/Output Devices

Switch Life Button - 3,000,000

Wheel - 1,000,000 times Tilt switch - 500,000 times

Cable Length 1850mm

PC98-99 PC99 compliant

 $\textbf{Regulatory Approvals} \qquad \quad \text{UL60950-1, UL 94, UL 746 (A-E), UL 796}$

TUV/GS: EN 60950-1, EN 60825-1

FCC Class B, UL 1950, cUL, TUV GS, CE, C-tick, VCCI, BSMI, RRL



Technical Specifications - Optical Storage

HP Blu-ray Writer Drive	Height	5.25-inch, half-height, tray-load			
	Orientation	Either horizontal or vertica	I		
	Interface type	SATA/ATAPI			
	Disc capacity	50 GB DL or 25 GB stand	lard		
	Dimensions (W \times H \times D)	5.9 x 1.7 x 7.5 in (15.0 x	4.4 x 19.0 cm)		
	Weight (max)	2.0 lb (907g)			
			Single-layer	Double-layer	
	Write speed	BD-R	2x, 4x CLV, 6x CAV	2x, 4x CLV	
		BD-RE	2.3x	2x CLV	
		DVD-R	2x, 4x CLV, 8x ZCLV, 8x, 12x PCAV, 16x CAV	2x, 4x CLV	
		DVD-RW	1x, 2x, 4x, 6x CLV	Not supported	
		DVD+R	2.4x, 4x CLV, 8x ZCLV, 8x, 12x PCAV, 16x CAV	•	
		DVD+RW	2.4x, 4x, 6x CLV, 8x ZCLV	Not supported	
		DVD-RAM	2x, 3x CLV, 3-5x PCAV		
		CD-R	8x,16x CLV, 24x, 32x P	CAV, 40x CAV	
		CD-RW	4x, 10x, 16x CLV, 24x 2	ZCLV	
			Single-layer	Double-layer	
	Read speeds	BD-ROM	6x CAV	4.8x CAV	
		BD-R	6x CAV	4.8x CAV	
		BD-RE (SL/DL)	4.8x CAV	4.8x CAV	
		DVD-ROM	16x CAV	8x CAV	
		DVD-R	12x CAV	8x CAV	
		DVD-RW	10x CAV	Not support	
		DVD+R	12x CAV	8x CAV	
		DVD+RW	10x CAV	Not support	
		BDMV (AACS Compliant Disc)	4.8x CAV		
		DVD-RAM	2x, 3x CLV, 3x-5x PCAV	/	
		DVD-Video (CSS Compliant Disc)	8x CAV		
		CD-R/RW/ROM	40x / 40x / 40x CAV		
		CD-DA (DAE)	32x CAV		
		80 mm CD	16x CAV		
	Sustained Transfer rate	BD-ROM	26.97 MB/s (6x) max		
		DVD-ROM	16.62 MB/s (16x) max.		
			10102 1112, 0 (1011) 1114111		
		CD-ROM	6,000 KB/s (40x) max.		



1.5Gbps bits/s (10b side) 1.2Gbps bits/s (8b side)

Burst Transfer rate

HP SuperMulti LightScribe Height

DVD Writer Drive

Technical Specifications - Optical Storage

Multimedia MPC-3 Yes

compliant

Access times Random DVD: < 140 ms (typical), CD: < 125 ms

(typical reads, including

setting) Full Stroke DVD: < 250 ms (seek), CD: < 210 ms (seek)

Power Source SATA DC power receptacle

> DC Power Requirement $5 \text{ VDC} \pm 5\%-100 \text{ mV ripple p-p}$ $12 \text{ VDC} \pm 5\%$ -200 mV ripple p-p

DC Current 5 VDC -1000 mA typical, 1600 mA maximum

12 VDC -600 mA typical, 1400 mA maximum

41° to 122° F (5° to 50° C) **Environmental** Temperature (operating)

(all conditions Relative Humidity non-condensing)

10% to 90%

(operating)

Maximum Wet Bulb 86° F (30° C)

Temperature (operating)

5.25-inch, half-height, tray-load

Either horizontal or vertical Orientation

Interface type SATA/ATAPI

8.5 GB DL or 4.7 GB standard Disc capacity

Dimensions (W \times H \times D) 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)

Weight (max) 2.6 lb (1.2 kg)

DVD-RAM Write speeds Up to 12X

> DVD+R Up to 16X DVD+RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-R Up to 16X **DVD-RW** Up to 6X CD-R Up to 48X CD-RW

Up to 32X DVD-RAM Read speeds Up to 12X

> DVD+RW, DVD-RW, Up to 8X

DVD+R DL, DVD-R DL

DVD-ROM DL Up to 8X DVD-ROM, DVD+R, Up to 16X

DVD-R

CD-ROM, CD-R Up to 48X

CD-RW Up to 32X

Access time Random DVD: < 140 ms (typical), CD: < 125 ms

(typical reads, including (typical)

settling) Full Stroke DVD: < 250 ms (seek), CD: < 210 ms (seek)

Power Source SATA DC power receptacle



Technical Specifications - Optical Storage

DC Power Requirement $5 \text{ VDC} \pm 5\%-100 \text{ mV ripple p-p}$

 $12 \text{ VDC} \pm 5\%$ -200 mV ripple p-p

DC Current 5 VDC (< 1000 mA typical, 1600 mA

maximum)

12 VDC (< 600 mA typical, 1400 mA

maximum)

Environmental conditions Temperature

(operating - noncondensing)

41° to 122° F (5° to 50° C)

Relative Humidity 10% to 90% Maximum Wet Bulb

86° F (30° C)

Temperature

HP DVD-ROM Drive Height 5.25-inch, half-height, tray-load

> Either horizontal or vertical Orientation

Interface type SATA/ATAPI

Single layer: Up to 4.7 GB (6 times capacity of CD-ROM) Disc capacity

Double layer: Up to 8.5 GB (12 times capacity of CD-ROM)

5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm) Dimensions (W \times H \times D)

2.6 lb (1.2 kg) Weight (max)

Read speeds DVD+R/-R/+RW/ Up to 8X

-RW/+R DL /-R DL

DVD-ROM Up to 16X DVD-RAM Up to 4X CD-ROM, CD-R Up to 48X CD-RW Up to 32X

Removable Storage -Media Compatibility -DVD-ROM

Media CD-ROM CD-R CD-RW DVD-ROM DVD-ROM DL DVD-RAM DVD+R DVD+R DL DVD+RW DVD-R DVD-RW DVD-R DL

Read Yes Yes Yes Yes Yes Yes

No No No Yes No Yes No Yes No Yes No Yes No

Access times (typical reads, including

setting)

Random

DVD: < 140 ms (typical), CD: < 125 ms

Write

No

No

No

No

(typical)

Full Stroke DVD: < 250 ms (seek), CD: < 210 ms (seek)

Cache Buffer 2 MB (minimum)



Technical Specifications - Optical Storage

Data Transfer Modes	ATA PIO mode 4 (16.7 MB/s); ATA Multi-word
---------------------	--

DMA mode 2 (16.7 MB/s); ATA UltraDMA Mode

3 (44.4 MB/s -default)

Power Source SATA DC power receptacle

> DC Power Requirement $5 \text{ VDC} \pm 5\%$ -100 mV ripple p-p

> > $12 \text{ VDC} \pm 5\%$ -200 mV ripple p-p

 $5 \, \text{VDC} - < 1000 \, \text{mA} \, \text{typical}, < 1600 \, \text{mA}$ DC Current

maximum

12 VDC -< 600 mA typical, < 1400 mA

maximum

Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions Relative Humidity 10% to 90% non-condensing) Maximum Wet Bulb 86° F (30° C)

Temperature

HP Slim SuperMulti LightScribe DVD Writer Drive

Height 12.7mm height

Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Disc recording capacity Up to 8.5 GB DL or 4.7 GB standard Dimensions ($W \times H \times D$) 5.0 x 0.5 x 5.0 in (128 x 13.6 x 129 mm)

Weight (max) 0.42 lb (190 g)

Write speeds DVD-RAM Up to 5X

> DVD-R DL Up to 4X DVD+R Up to 8X DVD+RW Up to 4X DVD+R DL Up to 4X DVD-R Up to 8X **DVD-RW** Up to 6X CD-R Up to 24X CD-RW Up to 16X

Read speeds DVD-RAM Up to 5X

> DVD-RW, DVD+RW Up to 8X DVD-R DL, DVD+R DL Up to 6X DVD+R, DVD-R Up to 8X DVD-ROM DL, DVD-Up to 8X

ROM

(typical reads, including

settling)

CD-ROM, CD-R Up to 24X CD-RW Up to 24X

Access time Random DVD: < 140 ms (typical), CD: < 125 ms

(typical)

Full Stroke DVD: < 250 ms (seek), CD: < 210 ms (seek)

Stop Time < 4 seconds Cache Buffer 2 MB (minimum)



Technical Specifications - Optical Storage

Data Transfer Modes ATA PIO mode 4 (16.7 MB/s); ATA Multi-word

DMA mode 2 (16.7 MB/s); ATA UltraDMA Mode

3 (44.4 MB/s - default)

Power Source Four-pin, DC power receptacle

> DC Power Requirement $5 \text{ VDC} \pm 5\%-100 \text{ mV ripple p-p}$

> > $12 \text{ VDC} \pm 5\%$ -200 mV ripple p-p

DC Current 5 VDC (< 1000 mA typical, 1600 mA

maximum)

12 VDC (< 600 mA typical, 1400 mA

maximum)

Total Drive Power < 2.5 Watt

(standby mode)

Audio output Line-Out 0.7 VRMS

> Signal-to-Noise Ratio 74 dB Channel Separation 65 dB

Environmental conditions

(operating - noncondensing)

Temperature 41° to 122° F (5° to 50° C)

10% to 90% Relative Humidity 86° F (30° C) Maximum Wet Bulb

Temperature

HP Slim DVD-ROM Drive Height 12.7mm

> Orientation Either horizontal or vertical

SATA/ATAPI Interface type

Dimensions ($W \times H \times D$) 5.0 x 0.5 x 5.0 in (128 x 13.6 x 129 mm)

Weight (max) 0.42 lb (190 g)

Read speeds DVD+R/-R/+RW/ Up to 4X

-RW/+R DL /-R DL

DVD-ROM Up to 8X CD-ROM, CD-R Up to 24X CD-RW Up to 24X

Access time

(typical reads, including

settling)

Random DVD DVD: < 140 ms (typical), CD: < 125 ms

(typical)

Random CD DVD: < 250 ms (seek), CD: < 210 ms (seek)

Data Transfer Modes ATA PIO mode 4 (16.7 MB/s); ATA Multi-word

DMA mode 2 (16.7 MB/s)

Power Source Four-pin, DC power receptacle

> DC Power Requirement $5 \text{ VDC} \pm 5\%-100 \text{ mV ripple p-p}$

DC Current 5 VDC - < 1000 mA typical, < 1600 mA

maximum

Total Drive Power < 2.5 Watt

(standby mode)



Technical Specifications - Optical Storage

Audio output Line-Out 0.7 VRMS

Signal-to-Noise Ratio 74 dB

Channel Separation 65 dB

Environmental (all conditions non-

condensing)

Temperature 41° to 122° F (5° to 50° C)

Relative Humidity 5% to 85% Maximum Wet Bulb 86° F (30° C)

Temperature (operating)



Technical Specifications - Removable Storage

HP 22-in-1 Media Card Reader (with 1394) **USB** Interface

USB 2.0 High-speed interface

NOTE: Requires the USB cable to be connected to the internal USB 2.0 port or a USB 2.0 PCl card.

1394 Interface

Two IEEE-1394a external ports; 1 IEEE-1394a internal port (connects to the pass through cable on the media card reader)

Advance protocol support

- Supports hardware ECC (Error Correction Code) function
 Supports hardware CRC (Cyclic Redundancy Check) function
- Supports MS 4-bit parallel transfer mode
- Supports MS-PRO 4-bit parallel transfer mode
- Supports MS PRO-HG Duo 4-bit parallel transfer mode
- Supports SD 4-bit parallel transfer mode
- Supports high-speed 50Mhz SD 4-bit card (version 2.0)
 Supports high-speed 52Mhz MMC 8-bit card (version 4.2)
- Supports CF v4.0 with PIO mode 6 and Ultra DMA mode

Supported media type

- CompactFlash Type I
- CompactFlash Type II
- Microdrive
- MultiMediaCard (MMC)
- Reduced Size MultiMediaCard (RS MMC)
- MultiMediaCard 4.2 (MMC Plus, including MMC Plus HC)
- Reduced Size MultiMediaCard 4.2 (MMC Mobile, including MMC Mobile HC)
- Secure Digital Card (SD)
- Secure Digital High Capacity (SDHC)
- miniSD
- miniSD High Capacity
- Micro SD (T-Flash)
- Micro SD HC
- Memory Stick
- Memory Stick Select
- Memory Stick Duo (MS Duo)
- Memory Stick PRO (MS PRO)
- Memory Stick PRO Duo (MS PRO Duo)
- Memory Stick PRO-HG Duo
- MagicGate Memory Stick (MG)
- MagicGate Memory Stick Duo
- xD-Picture Card

Supported media type with card adapter

Memory Stick Micro (M2)

• MMC Micro

Environmental

Operational
Environmental Extremes

Test Parameters/Conditions - Power applied, unit

operating on system $\pm 5\%$ nominal supply voltage. 10°C 10% R.H. = 24 hours

10°C 90% R.H. = 24 hours 20°C 90% R.H. = 24 hours

 30° C 90% R.H. = 24 hours 40° C 90% R.H. = 24 hours

 50° C 90% R.H. = 24 hours



Technical Specifications - Removable Storage

 50° C 10% R.H. = 24 hours

Storage Environmental

Extremes

Test Parameters/Conditions

140°F (60°C) @ 80% R.H. for 96 hours -22°F (-30°C) @ 20% R.H. for 48 hours

No power applied Delta °C < 1.0°C/min

Delta % R.H. < 1.5% R.H./min

Approvals

USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport Specification Rev. 1.0, Compliant Intel Front Panel I/O Connectivity Design

Guide V. 1.3

FCC, CE, BSMI, C-Tick, VCCI, MIC, cUL, TUV-T



Technical Specifications - Eco Data

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